

Part 1 & Part 2

STAND ALONE PRESSURE MEASUREMENT DEVICE (SAPMD) FOR THE SPACE SHUTTLE ORBITER

by

Bill Tomlinson

FINAL REPORT
NASA Contract NAS9-17601
SwRI Project 15-1062

for

National Aeronautics and Space Administration
Lyndon B. Johnson Space Center
Houston, Texas 77058

January 1989

(NASA-CR-172119-Pt-1) STAND ALONE PRESSURE
MEASUREMENT DEVICE (SAPMD) FOR THE SPACE
SHUTTLE ORBITER, PART 1 Final Report
(Southwest Research Inst.) 89 p CSCL 14B

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Unclassified
G3/35 0234604

INTRODUCTION

This document presents the final technical report for the development and delivery of a Stand Alone Pressure Measurement Device (SAPMD) and associated ground support equipment. This program was developed for the NASA/Johnson Space Center under NASA contract NAS9-17601 (SwRI Project 15-1062).

The data and documentation contained herein are the results of the development and successful completion of this contract.

Background

This program fulfilled the need to measure pressure at the surface of the thermal protective system tile on the space shuttle Orbiter during ascent, and in order to avoid the extensive impact associated with wiring the measurement into the Orbiter data system, the measurement device must be completely stand-alone and incorporate its own power supply and data recording facility. The device must be small enough to be mounted under the thermal protection system tiles and must be rugged enough to withstand the environments it will encounter at the bond line of the tiles throughout an Orbiter mission. It must be failsafe and data recorded during ascent must be recoverable after the mission without removal of the device.

Specifications

The SAPMD shall measure ambient pressure at the surface of the Orbiter TPS in the range of 0-15 pounds per square inch absolute (PSIA). Measurement will begin at solid rocket booster (SRB) ignition as sensed by appropriate vibration sensing elements in the SAPMD. Pressure and corresponding real-time data are to be recorded every one tenth second for 140 seconds and at the end of the recording period, the operation will be discontinued with the data preserved for interrogation subsequent to Orbiter re-entry and landing.

The type and size of the battery shall be such as to allow the vibration sensing elements and a real-time clock to be initialized a minimum of 30 days prior to launch and still provide power as necessary to perform the 140 second data recording period after SRB ignition. Battery installation shall be in such a manner as to allow battery replacement without removing the SAPMD from its position or removing more than one TPS tile.

The SAPMD must be mounted in specific locations under tiles of the Orbiter TPS. To accommodate such mounting, the absolute maximum physical dimensions must not exceed 6.0 inches in length, 1.5 inches in width and 0.4 inches in height, and the device shall be of such configuration that it can be bonded to the Orbiter skin at the joint line of two TPS tiles with the pressure sensing port at the surface of the tile. The SAPMD must remain operational in the temperature range of -40 to +85°C and survive storage temperatures of -55 to +125°C. The pressure port must withstand 934°C without causing damage to the TPS during entry and must remain functional at 262°C during ascent.

The accuracy of the pressure measurement must be plus or minus one-half pound per square inch absolute over a temperature range of 0 to +36°C.

Conclusion

All of the above specifications have been met and verified by prototype testing and is documented in the enclosed test data.

Four flight-qualified models were fabricated and of these, two have been delivered and successfully flown in the cargo bay of STS-26.

A contract modification changed the delivery of four flight models to two while modifying the remaining two for use in the nozzle bearing area of the SRB during a ground test at the Morton Thiokol site in Utah.

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"Flight Hazard Evaluation of the Lithium Thionyl Chloride Cell"

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HP.SAPMD Mechanical Schematics

HP.SAPMD GSE Software Listings

HP/SGA "Read Me"

SAPMD Acceptance Test Procedure

CEI SPECIFICATION

Specification No. 1062-CEI-01
Release Date: 19 October 1987

CONTRACT END ITEM SPECIFICATION

PERFORMANCE/DESIGN

AND

PROJECT CONFIGURATION

REQUIREMENTS

SE-176TA

STAND-ALONE PRESSURE MEASUREMENT DEVICE
FOR THE SPACE SHUTTLE ORBITER

CONTRACT NUMBER NAS 9-17601

Approved by: Rex R. Ritz
JSC Contracting
Officer
Houston, Texas


Approved by: William C. Gibson
Southwest Research
Institute
6220 Culebra Road
San Antonio, Texas

Approval date: _____

Approval date: 20 Oct 87

REVISION RECORD

REV	SCN. NUMBER	PAGES AFFECTED	PARAGRAPHS AFFECTED	DATE	APPROVAL

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1.0 INTRODUCTION

1.1 Scope

This specification establishes the requirements for complete identification and acceptance of a Stand-Alone Pressure Measurement Device (SAPMD) for the Space Shuttle Orbiter to be formally accepted by the Manned Spacecraft Center (MSC).

1.2 Engineering Baseline

The engineering baseline shall be established by a Critical Design Review (CDR) for this Contract End Item (CEI). All units of this CEI, regardless of intended use, shall be manufactured and accepted to the configuration defined by this specification and formally approved Engineering Change Proposals (ECP's)/Specification Change Notices (SCN's).

2.0 APPLICABLE DOCUMENTS

The following documents of the exact issue shown form a part of this specification to the extent specified herein. In the event of conflict between this specification and documents referenced herein, this specification shall take precedence.

Specifications-JSC

NHB 5300.4 (3A-1)	Requirements for Soldering of Electrical Connections
NHB 5300.4 (1D2)	Safety, Reliability, Maintainability, and Quality Provisions for the Space Shuttle Program
NHB 8060.1B	Flammability, Odor, and Offgassing Requirements
NHB 5300.4 (IC)	Inspection System Provisions
JSC 07700, Vol. IV	Configuration Management
JSCM 8080	Criteria and Standards
JSC 02681	Nonmetallic Materials Design Guidelines and Test Data Handbook
JSC-09604B	JSC GFE Materials Selection List and Materials Documentation Procedures
JSC-SE-R-0006B	NASA/JSC Materials and Processes
JSC 17481	JSC Safety Guidelines Document for Space Shuttle GFE
JSC-SL-E-0002B	Specification, Electromagnetic Interference Characteristics, Requirements for Equipment for the Space Shuttle Program
JSC-SP-T-0023B	Specification, Environmental Acceptance Testing
JSC/MSC-SPEC-M-1A	Marking and Identification
JSC SW-E-0002	Space Shuttle Program GSE General Design Requirements

Specifications-Rockwell

MF-0004-002B	Electrical Design Requirements for Electrical Equipment Utilized on the Space Shuttle Vehicle
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Standards-Military

MIL-STD-975E	NASA Standard (EEE) Parts List
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3.0 TECHNICAL REQUIREMENTS

3.1 Performance

The Stand Alone Pressure Measure Device (SAPMD) shall measure ambient pressure at the surface of the Orbiter TPS. The measurement range shall be 0 - 15 psia. The measurements shall begin at solid rocket booster (SRB) ignition as sensed by appropriate vibration sensors located within the enclosure incorporating the battery and electronics. Upon sensing SRB ignition, the SAPMD will monitor and record pressure for 140 seconds to a solid state non-volatile memory storage device. At the end of the recording period, the operation will be discontinued with the data preserved for interrogation subsequent to Orbiter entry and landing.

The SAPMD shall have a means to accurately time tag the recorded data in units of 1/2 seconds since January 1. The timekeeping and vibration sensor circuit shall be initialized 30 days before launch. The battery capacity shall be such that this timekeeping can be continued for a minimum of 50 days.

The block diagram shown in Figure 3-1 depicts the method in which the SAPMD shall process and record the pressure and time data. The heart of the system will be an INTEL 80C31, 8-bit CMOS processor with the program in electrically erasable programmable prom and the memory device shall be a 64K CMOS electrically erasable prom capable of 10-year data retention.

The battery supply shall be two each 600 mAH Lithium Thionyl Chloride batteries in a removable battery holder.

Data retrieval shall be accomplished with a battery-powered 80C88-based computer. Communication with the SAPMD shall be serial with additional connector pins to provide auxilliary power to the SAPMD.

The SAPMD shall be fabricated to meet the environmental conditions as specified in paragraphs 3.5.1 and 3.5.2 of the contract specification.

3.2 Product Configuration

Figure 3-2 Top Assembly Drawing.

3.2.1 Manufacturing Drawings

The configuration of the SAPMD shall be in accordance with drawing number 15-1062-457, and drawings and engineering data assembled thereunder, including all approved changes thereto. Class II changes to manufacturing drawings are allowable without NASA approval, however they are subject to classification review by NASA.

3.2.2 Government Furnished Property List

NONE

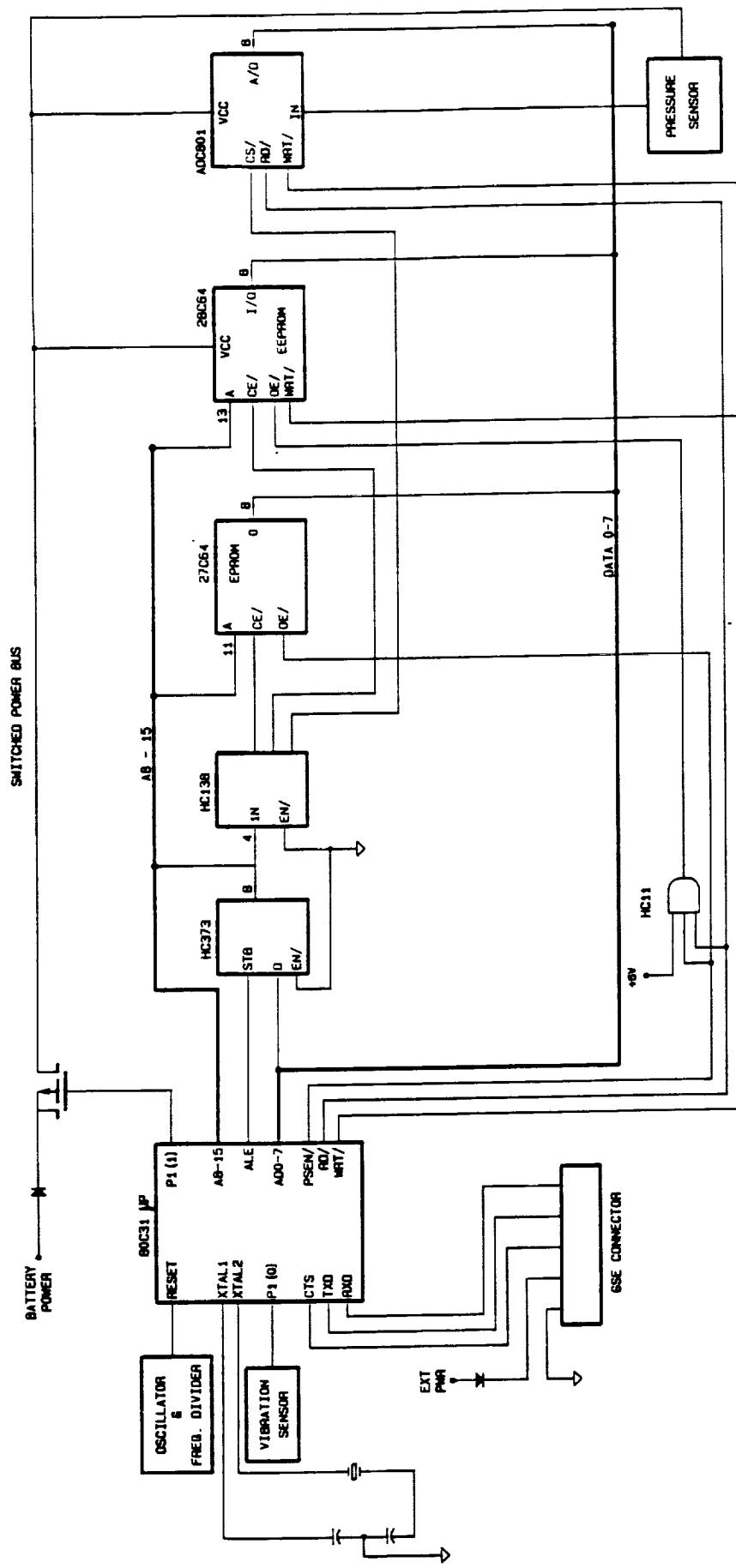


FIGURE 3-1. REVISED SAPMD BLOCK DIAGRAM

SAPMD ASSEMBLY

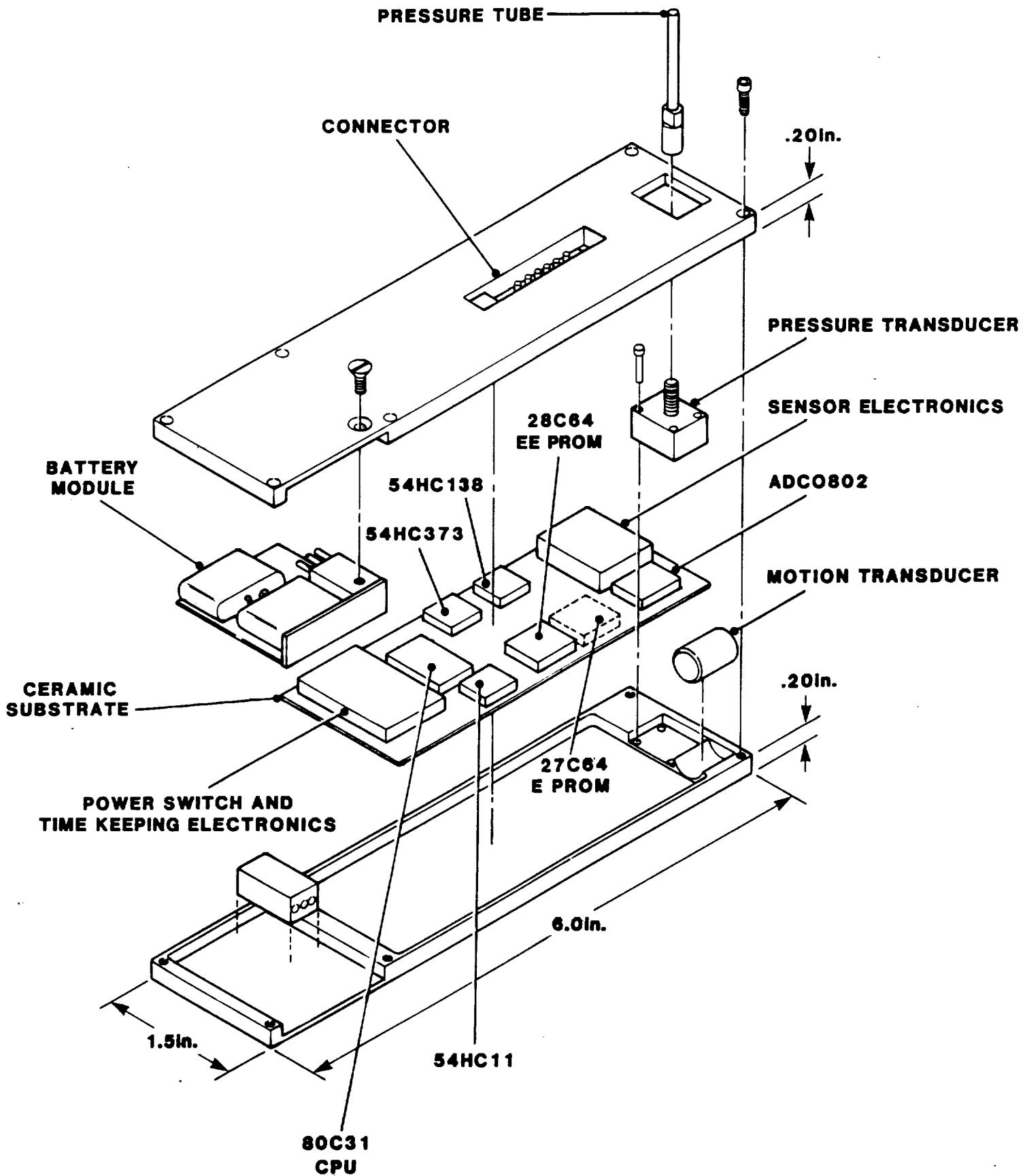


FIGURE 3-2 TOP ASSEMBLY DRAWING

3.2.3 Standards of Manufacturing, Manufacturing Processes, and Production

The applicability of the following publications to the SAPMD may be revised only by engineering changes having prior approval of NASA.

MIL-STD-975F

NASA Standard Electrical, Electronic, and Electromechanical (EEE) Parts List

Specifications-Military

None

Specifications-NASA

JSC/MSFC-SPEC-M-1A

Marking and Identification

JSC-SE-R-0006B

NASA/JSC Requirements for Materials and Processes

JSC-SL-E-0002A

Specification, Electromagnetic Interference Characteristics, Requirements for Equipment for the Space Shuttle Program

JSC-SP-T-0023B

Specification, Environmental Acceptance Testing

JSC SW-E-0002, Rev. B

Space Shuttle Program GSE General Design Requirements

Documents-NASA

JSC 07 700, Vol. IV
Rev. B

Space Shuttle Program Configuration Management Requirements (with changes through No. 60)

JSCM 8080

Manned Spacecraft Criteria and Standards

JSC-09604B

JSC GFE Materials Selection List and Materials Documentation Procedures

JSC 17481A

Safety Requirements Document for JSC Space Shuttle Flight Equipment

NHB 5300.4(3A-1)

Requirements for Soldering Electrical Connections

NHB 5300.4(1D2)

Safety, Reliability, Maintainability, and Quality Provisions for the Space Shuttle Program

NHB 8060.1B

Flammability, Odor, and Offgassing Requirements and Test Procedures for Materials, in Environments that Support Combustion

NHB 5300.4(1C)

Inspection System Provisions for Aeronautical and Space System Materials, Parts, Components and Services

Other Standards/Documents

Rockwell
MF-0004-002B

Electrical Design Requirements for Electrical Equipment Utilized on the Space Shuttle Vehicle

4.0 QUALITY ASSURANCE

Southwest Research Institute is responsible for accomplishment of each verification required herein.

4.1 Quality Requirements

4.1.1 Applicability of NHB 5300.4 (1D2)

Paragraphs 1D200 and 1D301.6.

4.1.2 Applicability of NHB 5300.4 (3A-1)

- A) Chapter 2, all paragraphs.
- B) Chapter 3, all paragraphs.
- C) Chapter 4, all but paragraphs 3A401, and 3A502.
- D) Chapter 8, all paragraphs.

4.1.3 Drawing Compliance

Written verification that the SAPMD has been fabricated, inspected, and tested to the latest applicable drawings identified in 3.2.1 and has incorporated the GFP specified in 3.2.2 will be provided at each Acceptance Review.

4.1.4 Additional Requirements

Paragraph 5.1.3, JSC document 20793.

4.2 Reliability Requirements

- A) Design per document JSCH 8080.
- B) Design Review (PDR and CDR).
- C) Limited life items identification per SwRI document 1062-LL-01.
- D) EEE parts per Mil-Std-975F (where possible).
- E) Derating per Mil-Std-975F, appendix A.

4.2.1 Additional Requirements

None

4.3 Test Requirements

Per contract NAS9-17601, latest revision.

5.0 PREPARATION FOR DELIVERY

5.1 Containers

Unless otherwise specified, the preservation, packaging, and packing shall be equivalent to the contractor's best commercial practice, provided that this practice will be sufficient to protect the SAPMD against damage during shipment. Exterior containers shall conform to Uniform Freight Classification Rules for rail shipment or National Motor Freight Classification Rules for truck shipment, as applicable.

5.2 Marking

Interior and exterior containers shall be marked in accordance with MIL-STD-129 "Marking for Shipment and Storage".

6.0 NOTES

6.1 Intended Use

The SAPMD, part number 15-1062-900-01, is intended for use in the measurement of ambient air pressure and the recording of that data in the vicinity of the Space Shuttle Orbiter exterior surfaces. Data thus acquired will be transferred to a portable computer system post flight for analysis and archiving.

6.2 Ordering Data

Procurement documents shall specify:

- (a) Contract End Item Specification for the Stand-Alone Pressure Measurement Device for the Space Shuttle Orbiter, SwRI Document No. 1062-CEI-01, date 20 October 1987.
- (b) Special precautions shall be applied to control of electrostatic discharge during all stages of parts procurement, storage, fabrication and test.

6.3 Definitions

A) SAPMD - Stand Alone Pressure Monitor Device

NOTICE: When MSC drawings, specification, or other data are used for any purpose other than in connection with a definitely related MSC procurement operation, the United States Government thereby incurs no responsibility nor any obligation whatsoever and the fact that MSC may have formulated, furnished, or in any way supplied the said drawings, specifications, or other data is not to be regarded by implication or otherwise as in any manner licensing the holder or any other person or corporation, or conveying any rights or permission to manufacture, use, or sell, any patented invention that may be in any way related thereto.

**FLIGHT HAZARD EVALUATION OF THE
LITHIUM THIONYL CHLORIDE CELL**

**FLIGHT HAZARD EVALUATION
OF THE
LITHIUM THIONYL CHLORIDE CELL**

PURPOSE OF EVALUATIONS

- * Temperature Vacuum Test
 - * Loss of Hermeticity of Package and Temperature at Which That Loss Occurred
 - * Electromechanical Failure
 - * Degradation of the Cell's Ability to Supply Power and Temperature at Which That Degradation Occurred
 - * Qualitative Rate of Failure Over Time

Temperature Vacuum Test Results

- * Temperature Risk of Less Than 5°c/min. Never Caused Violent Rupture of Case
- * Cell Continued to Produce Usable Power Even After Encapsulant Failure

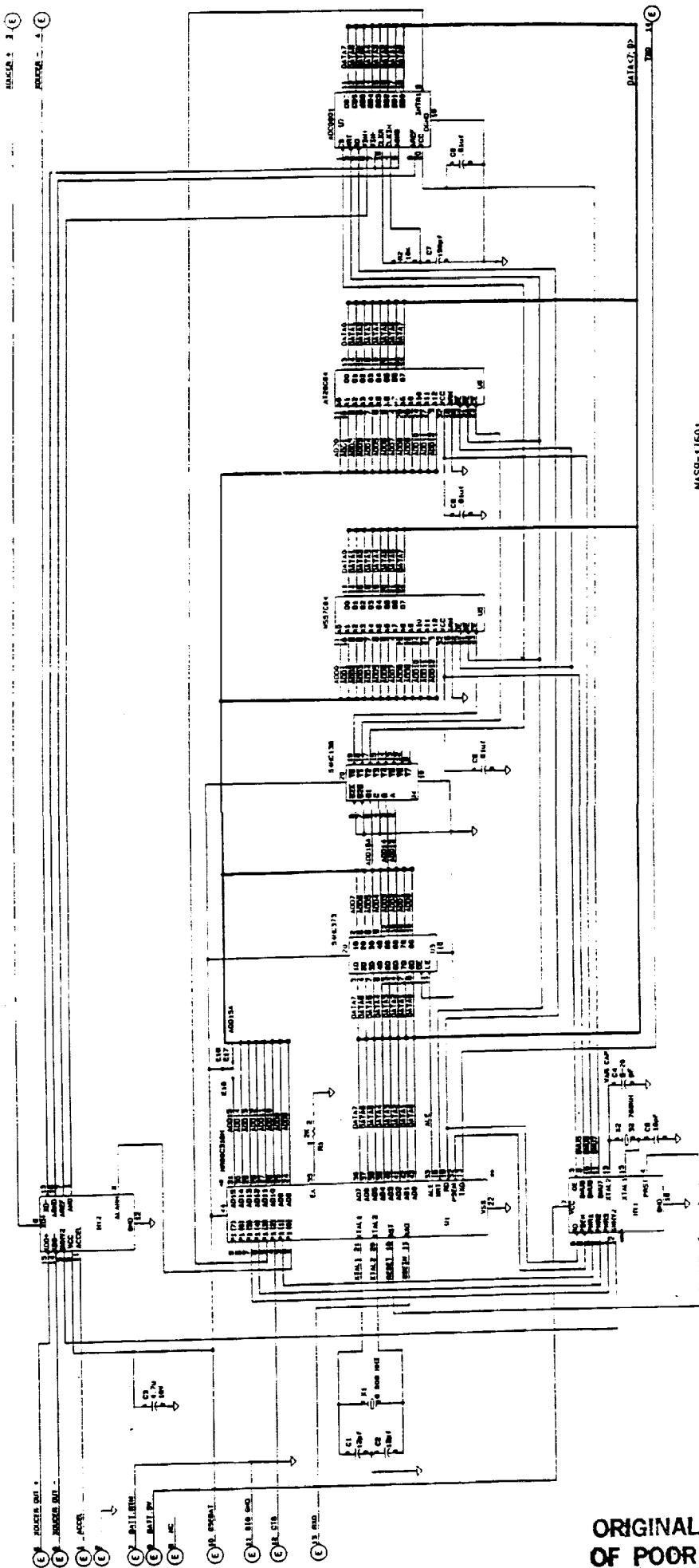
Purpose of Evaluations

- * Short Circuit Test
 - * Time Rate of Case Temperature Change
 - * Maximum Short Circuit Current
 - * The Degradation of the Cell's Ability to Supply Power

Short Circuit Test Results

- * Case Temperature Could Exceed 100°C With No Visible Damage To Case and No Loss of Encapsulant Integrity
- * Output Current Could Exceed 1.0 Ampere and Cell Could Still Produce Usable Power After Test

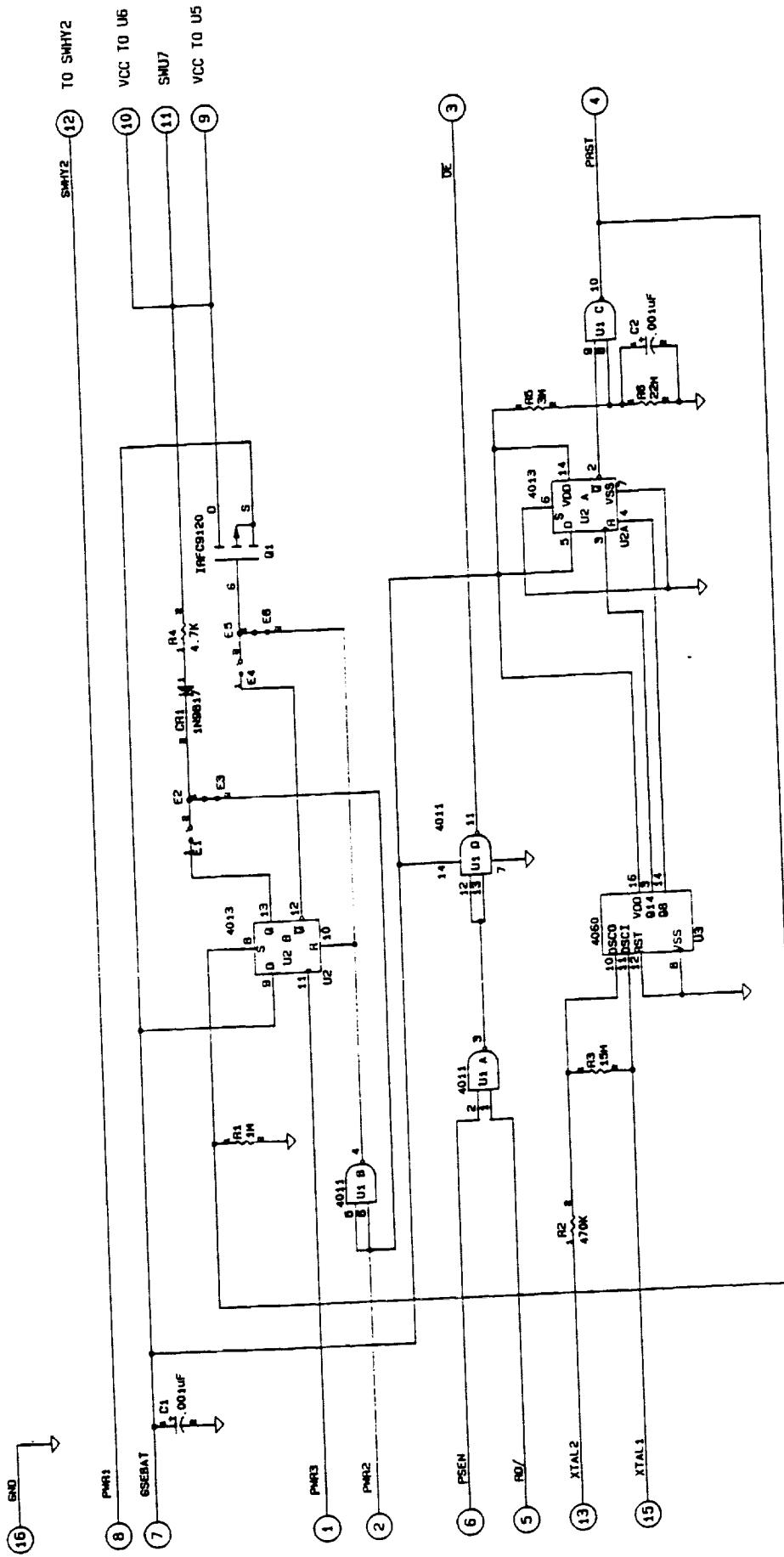
SAPMD SCHEMATICS



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OF POOR QUALITY

SAPMO ELECTRONIC SCHEMATIC

15-1062-301

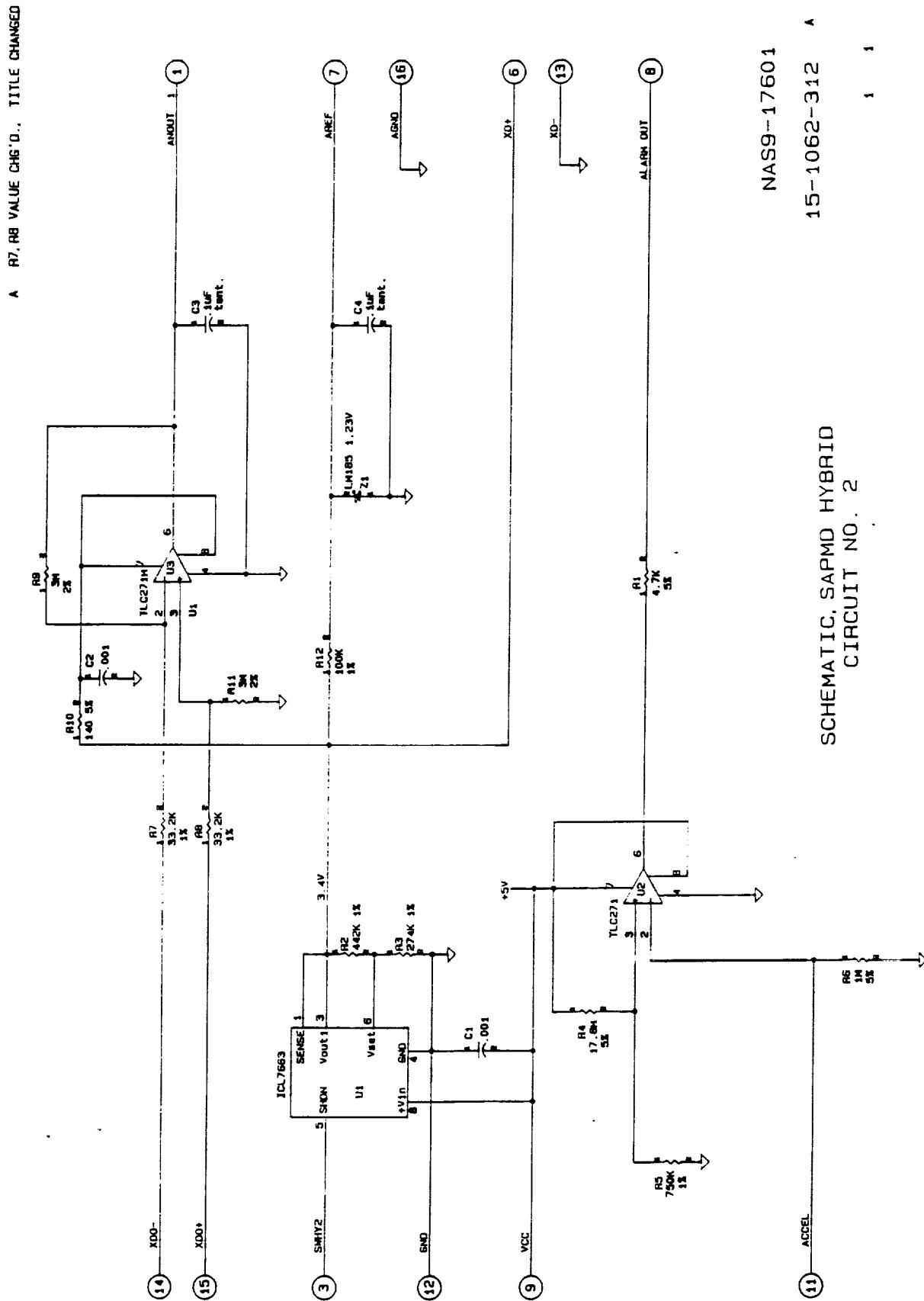


NAS9-17601

15-1062-311

SCHEMATIC, SAPMD HYBRID
CIRCUIT NO. 1

1 1



TEST DATA, PROTOTYPE

PROTOTYPE SAPMD TEST RESULTS

Initial Tests Conducted 3 March 1987 @ NASA Dryden Flight Research Center

- * Results Unacceptable
 - * Very High Zero Drift w/Temperature
 - * High Pressure Transducer Drift w/Temperature
- * Unit Returned to SwRI for Repair/ Calibration
 - * Error Sources Analyzed
 - * High Zero Drift w/Temperature from Pressure Transducer
 - * Large Error Resulting in Temperature Drift of Voltage Regulator
 - * Prototype Modified and Recalibrated
 - * Pressure Transducer Replaced w/Better Performing Unit
 - * Current Limit of Voltage Regulator Raised
 - * Thermistor Inserted in Series w/Pressure Transducer
 - * Extensive Calibration Performed Prior to Return to JSC
 - * Prototype Returned to JSC and Recalibrated on 6 July 1987
 - * SwRI Informed JSC Accepts Repaired Unit

RAW DATA, SAPMD MODIFIED PROTOTYPE PERFORMANCE AT JSC JULY 6-8, 1987

185 F

TOP TEMPERATURE

PRESS DECREASING PRESS INCREASING

TEMP PRESS TEMP PRESS

14.7

185 13.71

14

183 13.00 181 13.00

12

185 11.01 183 11.01

10

186 9.02 183 8.95

8

187 7.03 184 6.96

6

187 5.05 185 5.05

4

186 3.06 185 3.06

2

187 1.14 181 1.14

0.03

185 0.00

122 F

TEMPERATURE INCREASING

PRESS DECREASING PRESS INCREASING

TEMP PRESS TEMP PRESS

14.7

122.2 14.71

14

123.2 14.14 123.7 14.00

12

122.7 12.01 123.8 11.94

10

121.2 9.95 123.8 9.88

8

120.5 7.89 122 7.82

6

122.6 5.83 123.8 5.76

4

120.7 3.84 120.9 3.77

2

124 2.13 123.2 1.78

0.03

122.3 0.00

TEMPERATURE DECREASING

PRESS DECREASING PRESS INCREASING

TEMP PRESS TEMP PRESS

121 14.57

122 13.79 123 13.79

121 11.80 121 11.72

123 9.66 123 9.66

121 7.60 121 7.60

122 5.61 122 5.54

122 3.55 122 3.62

118 1.56 118 1.56

122 0.00

TEMPERATURE INCREASING

PRESS DECREASING PRESS INCREASING

TEMP PRESS TEMP PRESS

TEMPERATURE DECREASING

PRESS INCREASING

TEMP PRESS

95 F

94.7 15.21

14

96.6 14.35 95.8 14.28

12

95.4 12.36 93.8 12.22

10

95.7 10.16 94.4 10.16

8

96.7 8.17 97 8.17

6

94.7 6.11 94.3 6.04

4

93.8 4.05 95.7 3.98

2

96.3 2.13 93.4 1.92

0.03

94.5 0.00

TEMPERATURE DECREASING

PRESS DECREASING

TEMP PRESS

97 14.85

97 14.07 93.7 14.14

96.6 12.01 96.6 12.01

94.2 10.02 94.2 9.81

95.3 7.82 95.3 7.82

94.1 5.83 94.1 5.83

93.9 3.77 93.9 3.77

95.8 1.71 95.8 1.71

96 0.00

75 F

INITIAL

TEMPERATURE INCREASING

PRESS DECREASING PRESS INCREASING

FINAL

PRESS DECREASING

TEMP PRESS

75.2

75.2 15.49

14.5

76.5 14.57 77.0 14.57

12.4

75.4 12.44 76.2 12.51

10.4

76.4 10.45 76.6 10.37

8.3

74.5 8.31 75.3 8.31

6.2

75.7 6.25 77.0 6.32

4.1

76.5 4.12 73.5 4.12

2.0

73.5 2.06 73.4 2.06

0.03

76.2 0.00

75.3 0.00

32 F

TEMPERATURE INCREASING

PRESS DECREASING PRESS INCREASING

PRESS INCREASING

TEMP PRESS

32.7

32.7 15.35

33.1

33.1 14.78 31.0 14.85

32.4

32.4 12.65 30.4 12.79

32.2

32.2 10.52 30.4 10.66

30.7

30.7 8.60 32.6 8.53

34.0

34.0 6.40 32.7 6.47

32.0

32.0 4.33 30.7 4.41

31.6

31.6 2.27 30.0 2.27

30.0

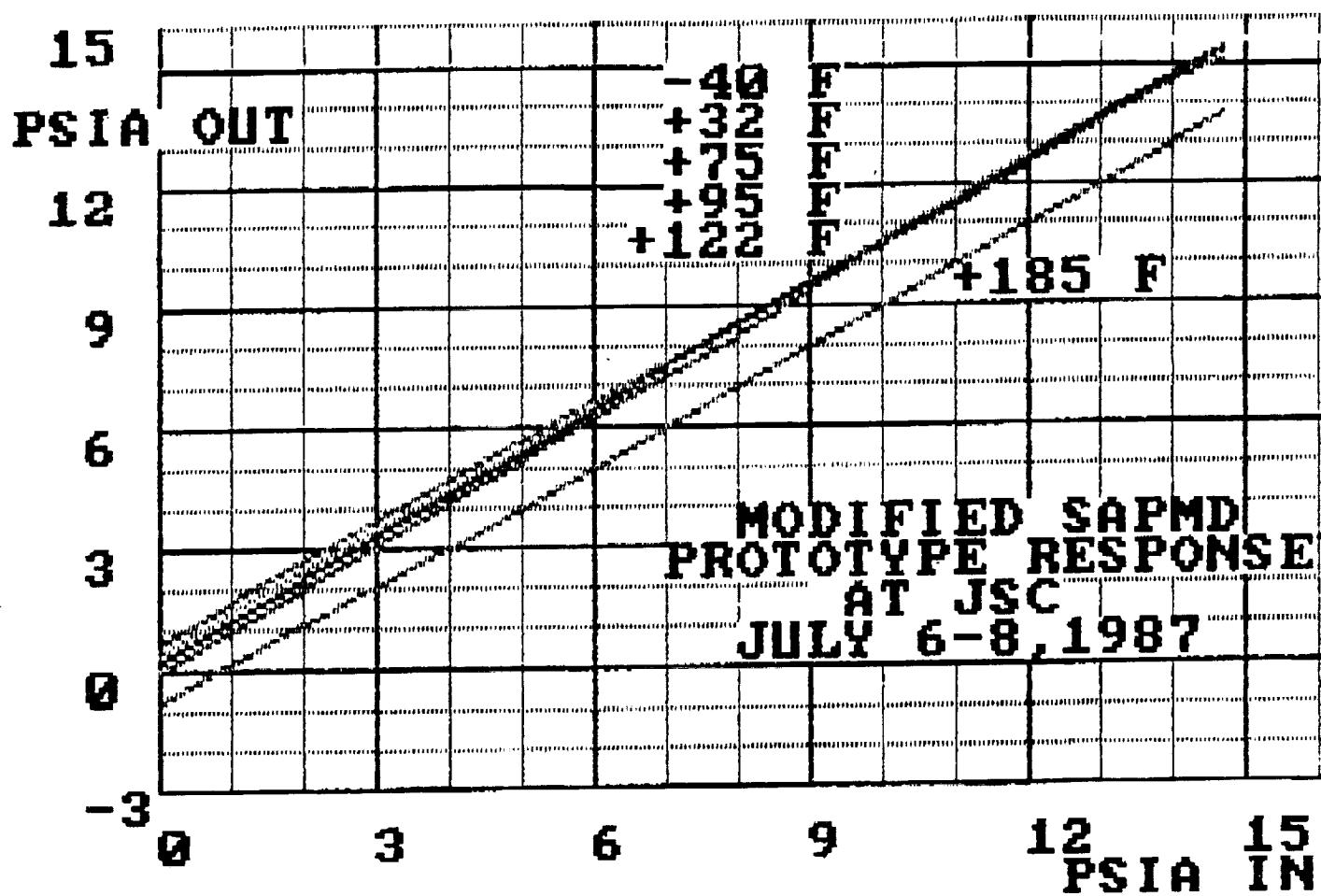
30.0 0.21

32.9 0.28

RAW DATA, SAPMD MODIFIED PROTOTYPE PERFORMANCE AT JSC JULY 6-8, 1987

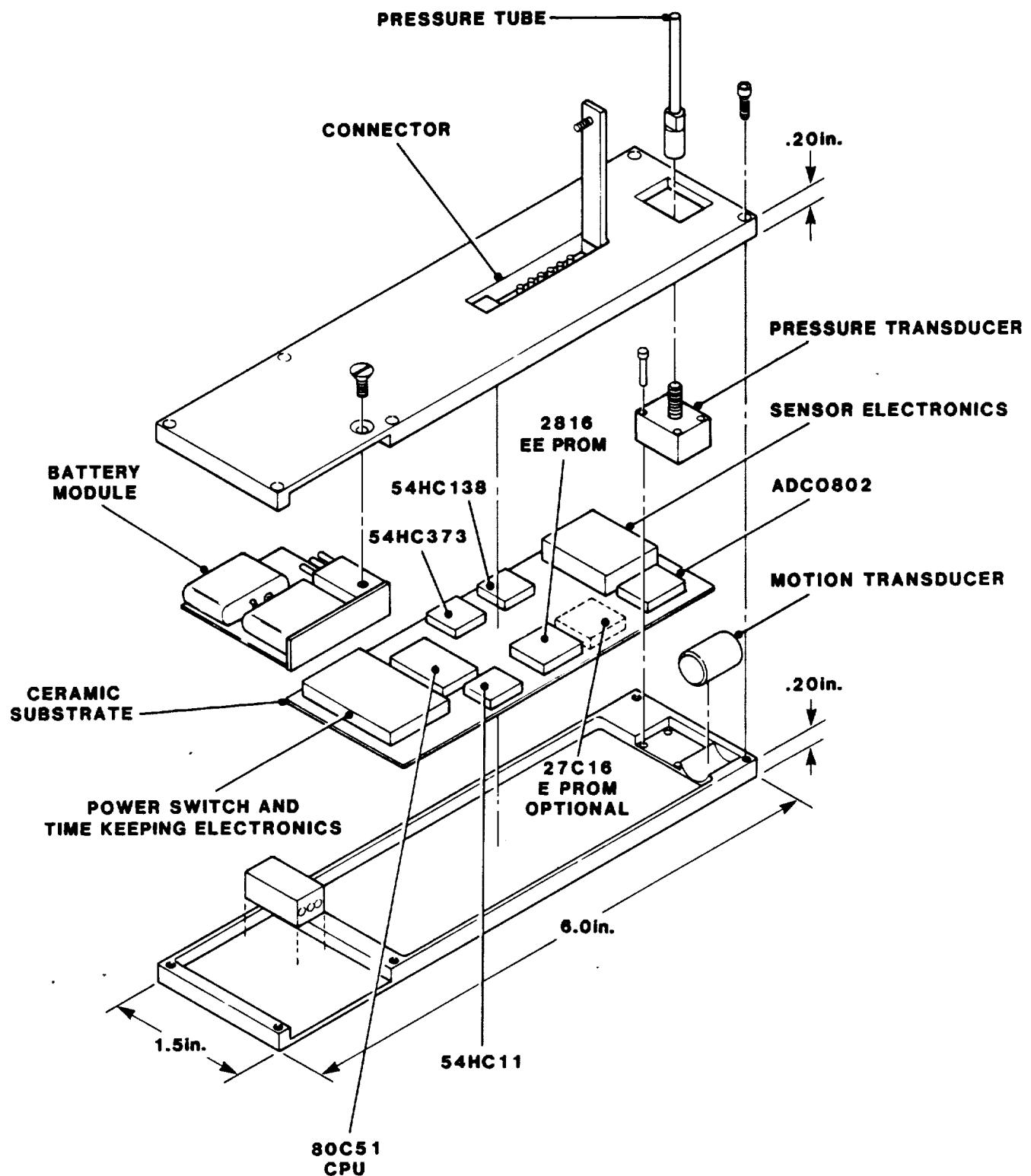
O F	TEMPERATURE DECREASING				TEMPERATURE INCREASING			
	PRESS DECREASING	PRESS INCREASING	PRESS DECREASING	PRESS INCREASING	TEMP	PRESS	TEMP	PRESS
14.7	1.1	15.49			1.0	15.63		
14	-1.9	14.78	0.1	14.78	-2.0	15.63	0	14.85
12	-1.9	12.79	0.1	12.72	-1.0	12.86	4	12.79
10	-0.3	10.66	-2.0	10.66	-2.0	10.80	4	10.66
8	0.4	8.60	0.4	8.67	-2.0	8.74	1	8.67
6	-0.3	6.54	-1.3	6.54	-1.0	6.68	0	6.68
4	-1.5	4.55	1.3	4.55	0.0	4.62	-2	4.55
2	1.3	2.49	0.6	2.49	-0.6	2.63	-2	2.56
0.03	1.0	0.43			-1.0	0.64		

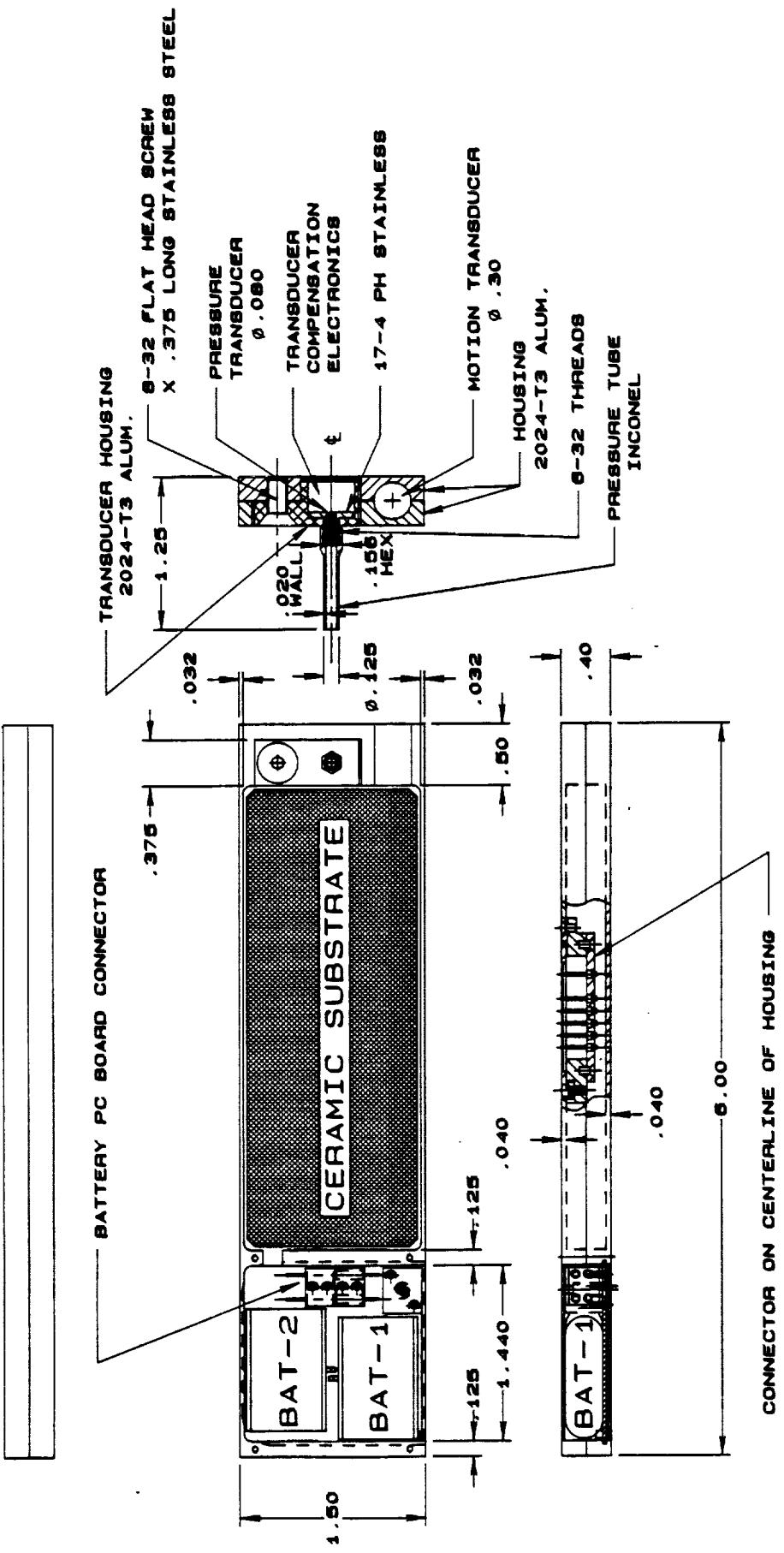
-40 F	BEFORE COLD SOAK		AFTER COLD SOAK	
	PRESSURE DECREASING	PRESSURE INCREASING	TENP	PRESS
14.7	-41.2	15.14		
14	-41.3	14.57	-41	15.28
12	-41.5	12.58	-37	12.44
10	-39.2	10.59	-40	10.52
8	-38.5	8.53	-41.0	8.53
6	-41.6	6.68	-41.0	6.54
4	-40.0	4.69	-41.5	4.69
2	-42.0	2.70	-42.0	2.70
0.03	-40.0	0.64	-42.0	0.85



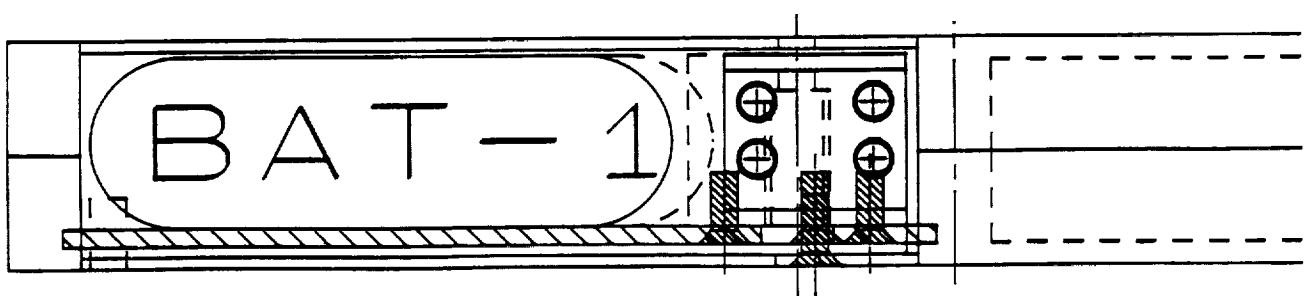
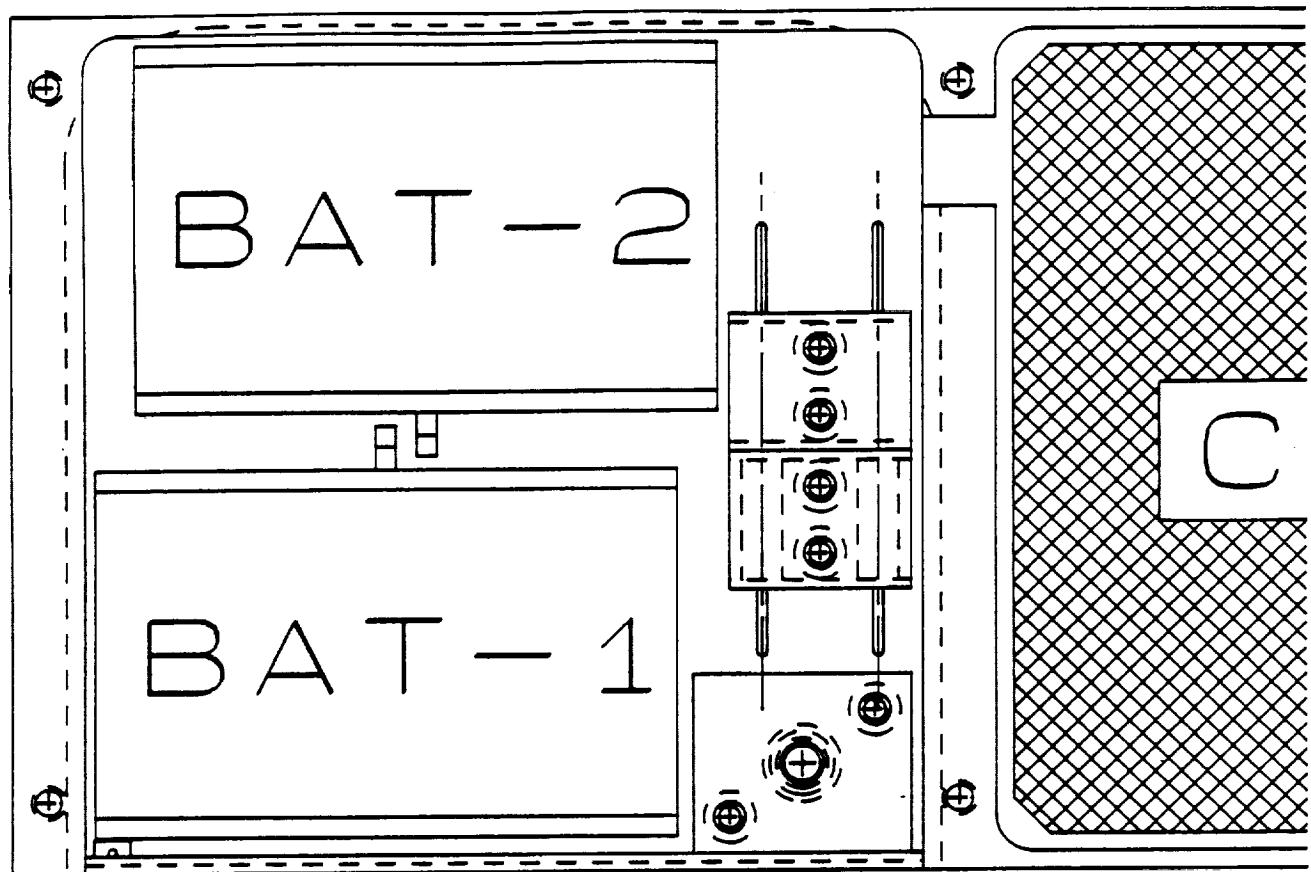
SAPMD ASSEMBLY DRAWING

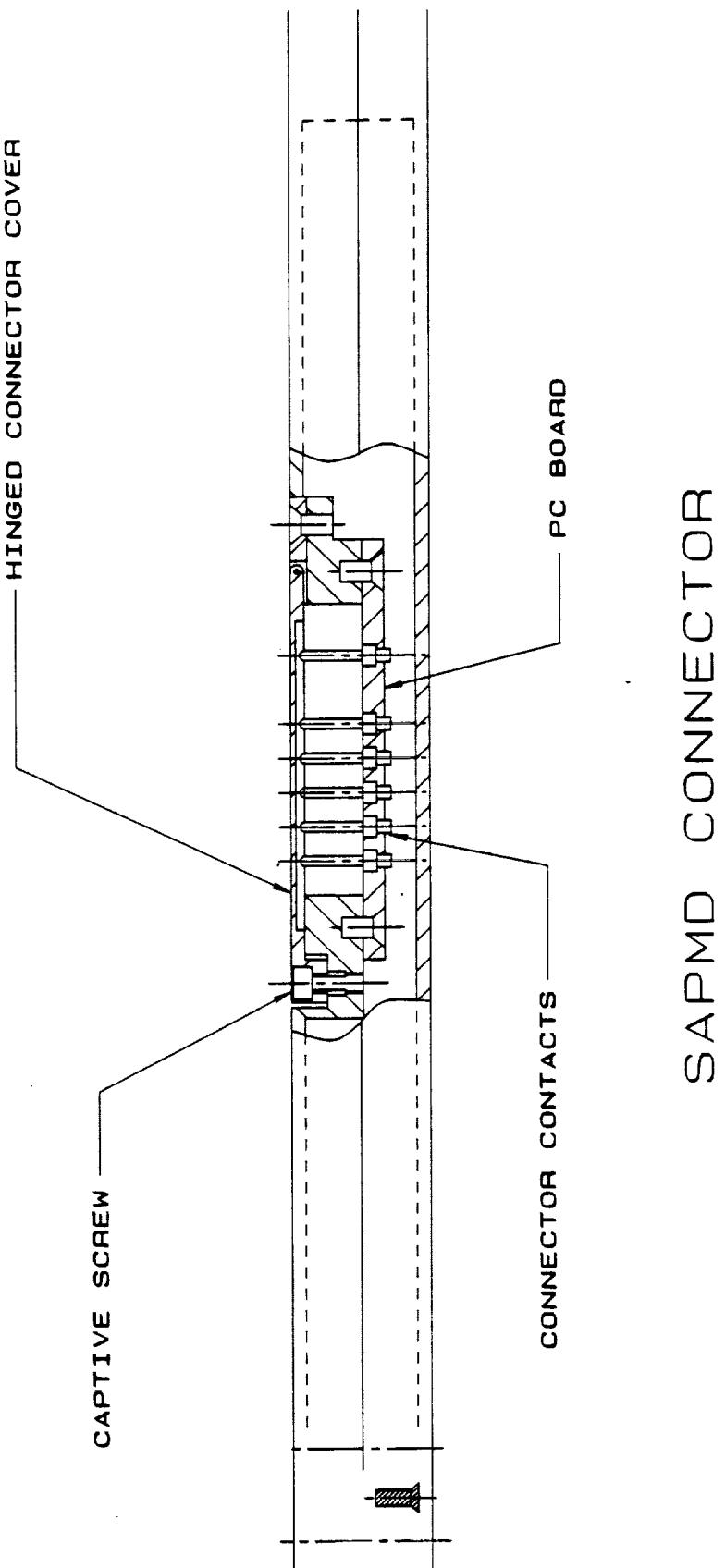
SAPMD ASSEMBLY



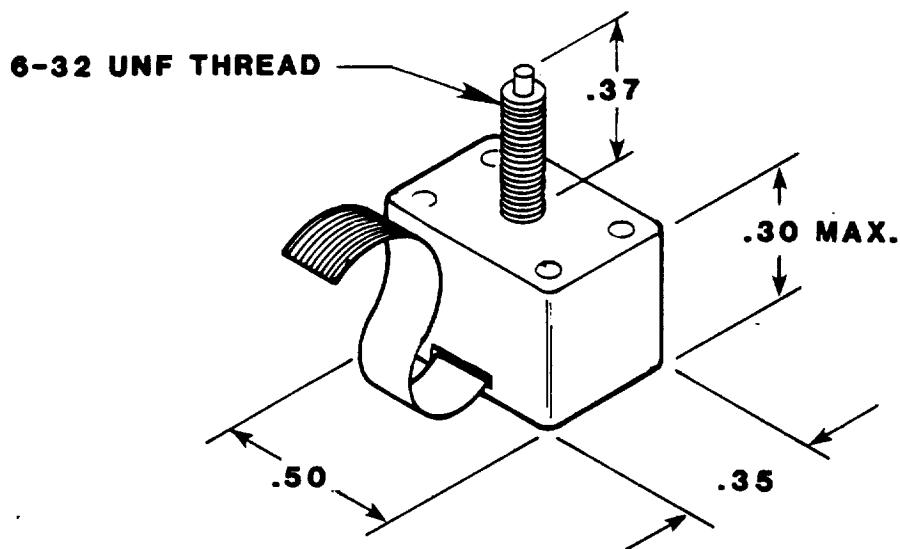


SAPMD

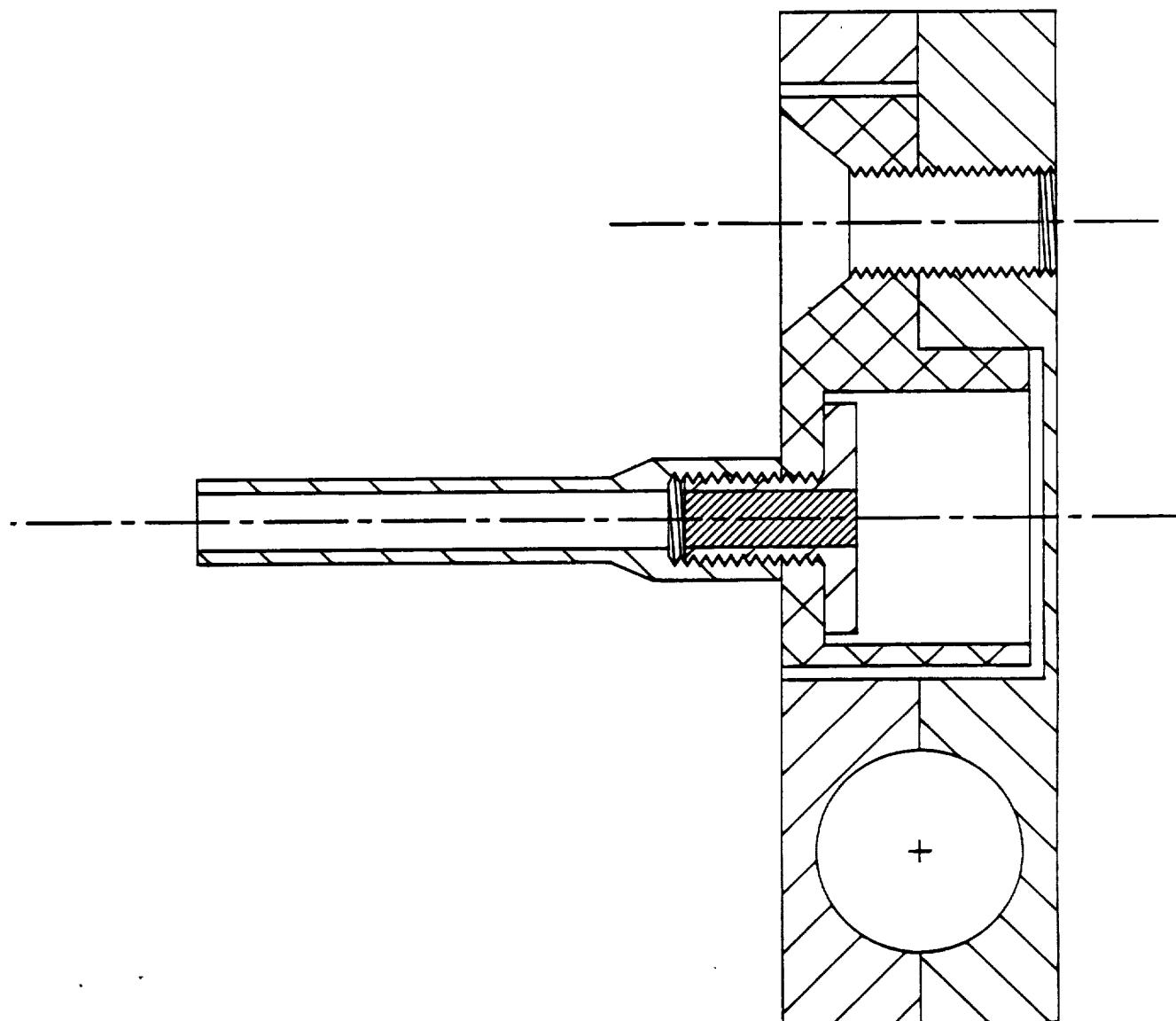


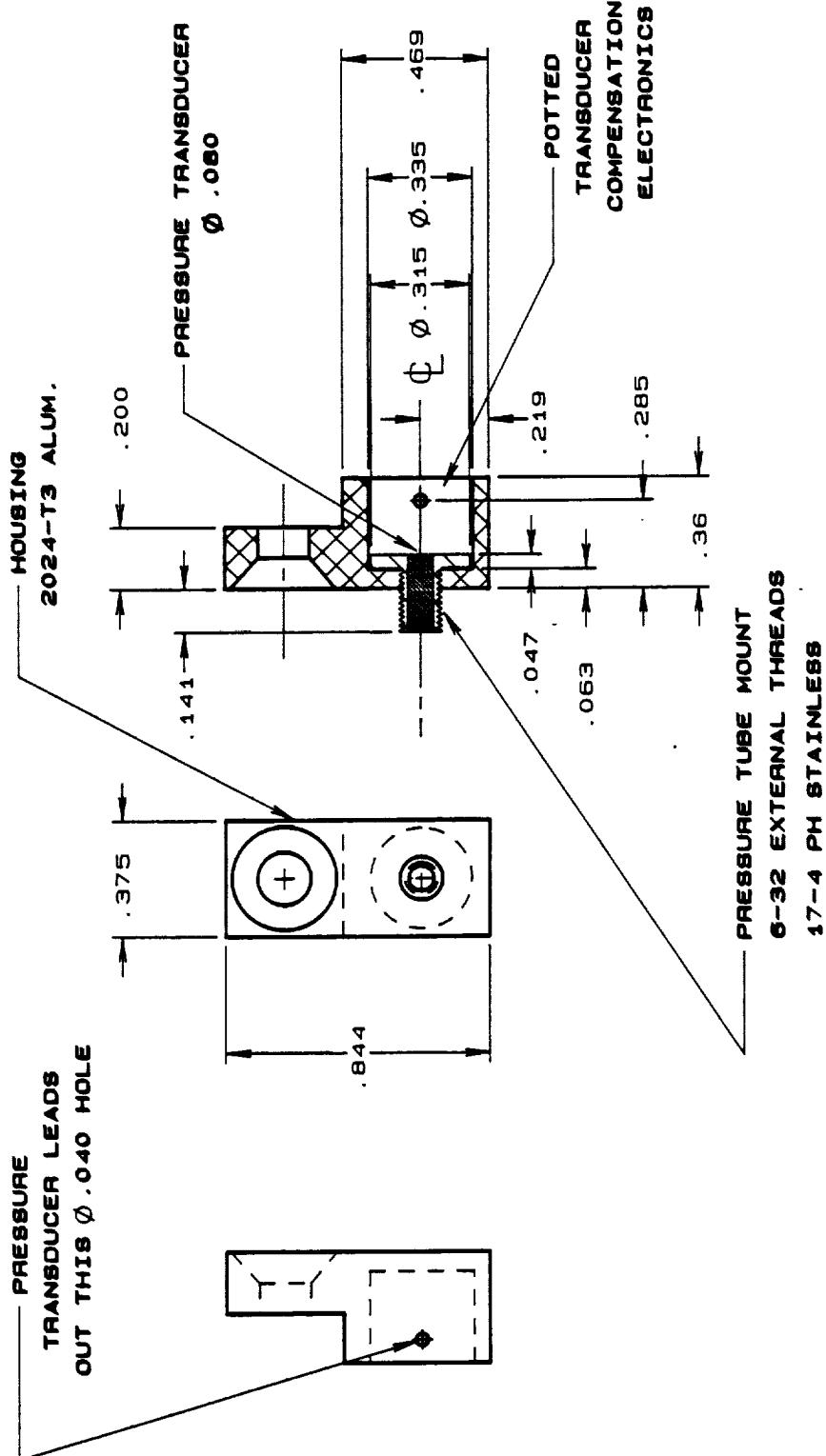


PRESSURE TRANSDUCER

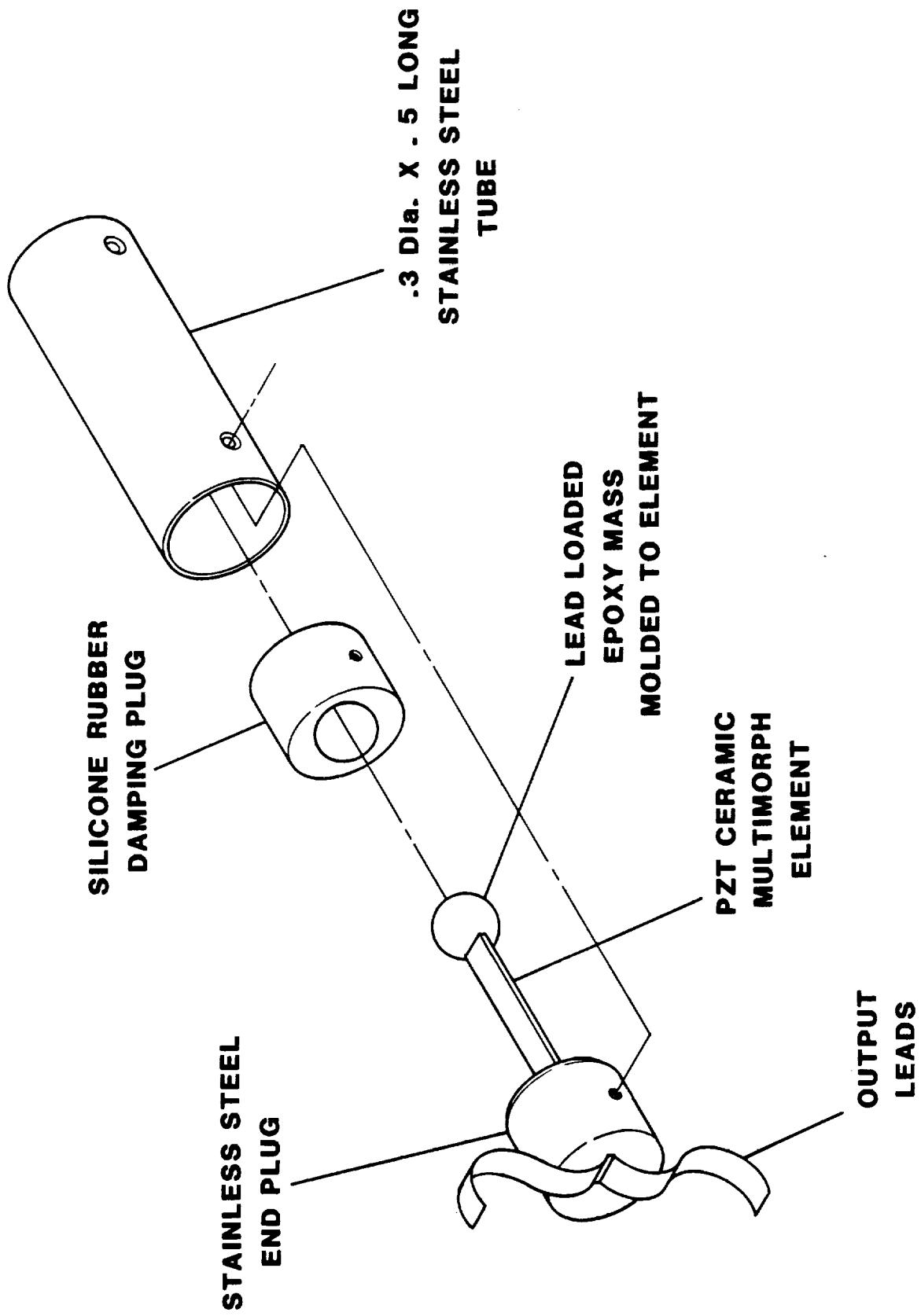


- ENTRAN EPI-080 TYPE PRESSURE TRANSDUCER
- CUSTOM PACKAGE
- INTERNAL COMPENSATION
- SILICON DIAPHRAM
- EXCITATION 5VDC
- STAINLESS STEEL HOUSING





VIBRATION SENSOR



FLIGHT SOFTWARE SUMMARY

**SUMMARY OF
SAPMD FLIGHT SOFTWARE FUNCTIONS**

- * Detect Launch
- * Log Pressure Data
- * Hardware Self-Test
- * Interact with GSE

SAPMD FLIGHT SOFTWARE MODULES

- | | | |
|----------------|---|--|
| * INIT | - | Check for Power-On or Tick Reset, Arm Watchdog Timer |
| * TICK | - | Update Internal Clocks |
| * Launch | - | Detect Launch and Record Pressure Sample |
| * GSE | - | Communicate with SAPMD GSE |
| * TIMEOUT | - | Suspend Operation of SAPMD Pending Reset |
| * STATUS | - | Transmit Current SAPMD Status Over Serial Line |
| * HANG | - | Enter 80C51 Power-Down Mode |

SAPMD FLIGHT SOFTWARE EXECUTION LEVELS

- * Critical Functions (High Priority)

Must Execute to Completion; Cannot be Suspended and Resumed or Interrupted by Reset.

INIT	-	Reset Test (Check Memory Bit Pattern)
TICK	-	Update Clocks
TIMEOUT	-	Suspend Operation

- * Control Functions (Low Priority)

May be Interrupted by TIMEOUT, Suspended and Resumed

LAUNCH	-	Detect Launch, Record Pressure Sample
GSE	-	Communicate with GSE
STATUS	-	Transmit SAPMD Status

CONFIGURING SAPMD FLIGHT SOFTWARE

- * SAPMD Operating Parameters in RAM/EEPROM may be Altered Using GSE

EEPROM Resident Parameters

Pressure Samples Recorded

First Free EEPROM Address

EEPROM Size

SAPMD Serial Number

RAM Resident Parameters

Branch Points - Bail Out for S/W

Clocks

Timeout Duration

EEPROM Power Switch

80C51 Special Function Resistor (SFR) Images

Launch Detect Counter

SAPMD SELF-TESTS

- * **EEPROM Self-Test**
 - * Address Test
 - * ALL 55H
 - * ALL AAH
 - * ALL FFH
 - * ALL 00H
- * **Power System Test**
- * **A/D Converter Test**
- * **Pressure Transducer Test**
- * **80C51 RAM Test - Forces Power-On Reset**
- * **80C51 ROM Test**
 - * Compute and Compare with Recorded Checksum

PRESSURE DATA RECORDING FORMAT

- * Up to 3 Acquisition Cycles in 2K EEPROM
- * Each Sample Numbered
- * Pressure File Format:

<u>Byte</u>	<u>Content</u>
0-3	GMT at Launch Detect
4-563	Pressure Samples

- * Pressure Sample Format:

<u>Byte</u>	<u>Content</u>
0	Sequence #Mod 256
1	Pressure Transducer Reading

SAPMD STATUS INFORMATION

- * Transmitted Every Tick
- * Status Information:
 - * EEPROM Powered
 - * Self-Test in Progress
 - * GSE Transaction in Progress
 - * Data Acquisition in Progress
 - * Acquisition Complete
 - * Error
- * RAM Dump:
 - * RAM Block may be Dumped with Status to Monitor SAPMD Operation
- * Status Information Displayed on GSE (GRID)

SGA SOFTWARE SUMMARY

**SUMMARY OF
SAPMD GSE SHUTTLE GAUGE ACCESS (SGA) SOFTWARE**

- * **Menu Driven**
- * **Main Menu**
- * **2 Branch Menus**
- * **Allows Interactive Access to SAPMD**
- * **Provides SAPMD Calibration Offsets**

SGA MAIN MENU

- 1. COMMAND/INTERROGATE SAPMD**
- 2. SAPMD SELF-TEST**
- 3. RECOVER PRESSURE DATA FILENAME**
- 4. DISPLAY PRESSURE DATA FILENAME**
- 5. PRINT PRESSURE DATA FILENAME**

SELECT OPTION:

* Options 1 and 2 use Branch Menus

OPTION 1: COMMAND/INTERROGATE SAPMD MENU

SG ddd/hh:mm:ss	Set GMT
SM ddd/hh:mm:ss	Set MET
TM	READ Clocks
DR xx[.yy]	DUMP 80C51 RAM From xx for yy Bytes
DE xxxx[.yy]	DUMP 80C51 External Memory xxxx for yy
DS xx	DUMP 80C51 SFR
ER xx	ENTER 80C51 RAM at xx
EE xxxx	ENTER 80C51 External Memory at xxxx
ES xx	ENTER 80C51 SFR
P Filename	PROGRAM Filename into EEPROM
MON	TOGGLE Monitor Data Window Display

>

* Commands are Entered Following ">" and Scroll Beneath Menu

OPTION 2: SAPMD SELF-TEST MENU

- 1. PERFORM ALL TESTS**
- 2. EEPROM TEST**
- 3. POWER SYSTEM TEST**
- 4. A/D CONVERTER TEST**
- 5. PRESSURE TRANSDUCER TEST**
- 6. 80C51 RAM TEST**
- 7. 80C51 ROM TEST**

SELECT OPTION:

* Test Executed and Completion Status Displayed by SGA

SAPMD STATUS DISPLAY

- * Status Line:
 - * EEPROM-On Self-Test GSE Acquisition Complete Error
- * Displayed on Top Line of All Menu Screens
- * Active Functions Indicated by Flashing Reverse Video
- * Dumped RAM Displayed on Dedicated Window Which Replaces Command/Interrogate Menu
- * "MON" Command Alternately Displays Monitored RAM Window or Command Menu

SAPMD<-->SGA DIALOG

- * All Commands and Responses ASCII
- * Command Character Reception Acknowledged by Echo
- * SGA or SAPMD May Abort Command at Any Time
- * All Commands Generate Completion Response
- * Status and Dumped RAM Data are Binary, Distinguished by Set High Order Bit of First Message Byte

SAPMD CALIBRATION

- * Calibration Information
 - * SAPMD Serial Number
 - * Pressure Transducer Zero Bias
 - * Number of Counts to Subtract from Each Sample
to Adjust for Transducer Error
 - * PSI/Count for Transducer Samples
- * File is "SAPMD.CAL"

HP.SAPMD CEI SPECIFICATION

1.0 **INTRODUCTION**

This specification establishes the requirements specified in NAS9-17601, Request for Engineering Change Proposal dated April 19, 1988 for the design, development, fabrication, testing and delivery of two (2) Stand-Alone Pressure Measurement Devices (SAPMD) based on the design of the existing SAPMDs for the Shuttle Orbiter. The revised design will be capable of operation in a 1000 psi, 187°F environment for use in the Solid Rocket Booster (SRB) tests. The main tasks of this new work is the design of a high-pressure housing, substitution of a high-pressure sensor and design of a longer life battery supply.

1.1 Background

The present design of the SAPMD incorporates a microprocessor system implemented with hybrid module techniques using low power CMOS units which are contained in a 0.4-in. thick metal housing. The system is designed to operate installed under selected heat shield tiles on the Shuttle Orbiter and to thus survive and operate in a pressure regime from near zero psi to atmospheric pressure (14.7 psi). The unit operates from self-contained lithium batteries which provide an operating lifetime in the sleep mode of 1200 hours. The system is awakened by sensing the vibration of launch and takes pressure data for a period of 140 seconds with data readings every 100 ms. On-board real-time clock data are recorded with the pressure data. The data are recorded in EEPROMs which are capable of retaining the data indefinitely at temperatures up to 257°F. After retrieval of the module, data are supplied to GSE equipment for further use.

1.2 Specification Changes

In order to meet the requirements imposed by the SRB tests, the SAPMD must be redesigned to accommodate the new test environment. First, the housing of the SAPMD must be redesigned to survive a pressure of 1000 psi with at least a 50 percent overpressure capability. Protection of the internal electronic circuits from any mechanical stress is important for both reliability and accuracy. Second, a new pressure sensor must be selected which can measure pressures from 14.7 to 1000 psi with an accuracy of one percent FS over an ambient temperature range of 100 to 300°F. Third, the battery power supply must be modified to provide a lifetime of 2400 hours (100 days) of power-down operation. Forth, a new circuit must be added to allow an external hard-wired control line to activate the system prior to ignition. This circuit replaces the vibration sensor used to detect launch.

2.0 TECHNICAL APPROACH

The following paragraphs describe the technical work on the three tasks required to modify the SAPMD design for high pressure measurements.

2.1 Mechanical Design

The housing of the modified SAPMD shall be designed for operation at 1000 PSIA and 185°F. The housing of the monitor as shown in Figure 1 will contain the electronic circuits, batteries, and pressure transducer. The bottom cover of the housing is removable to provide access to the batteries and the data connector. The cover is sealed with an O-ring to insure that the internal pressure does not rise above 50 PSIA. The internal pressure must be limited since the batteries are sealed units and cannot withstand the high external ambient pressure. The housing structure shall be designed to withstand a maximum of pressure of 2000 PSIA to provide a 100% overpressure safety factor. If higher over-pressures are expected, the housing design can be modified either by the use of higher strength materials or by an increase in housing dimensions. The proposed design incorporates 300 series stainless steel as the housing material. The proposed design has no mounting holes assuming the unit will either be clamped or bonded in position. The design may be readily changed to provide attachment points if so required.

2.2 Electronic Design Changes

The changes in the electronic design of the SAPMD will be primarily in the start and stop command circuitry and, if necessary, to the bias circuit of the high-pressure transducer. The external start command will require additional circuitry included on the new battery board which will contain four (4) model LTC-7PN lithium batteries.

The start command will be controlled by a pair of wires connected to the high-pressure feed-thru of the SAPMD and routed outside the nozzle opening to a relay. This relay operation will be under control of the local firing-range officials and will be operated prior to ignition.

The contact closure activates a latch circuit inside the SAPMD which in turn enables a micro-powered voltage regulator to supply +5V to the SAPMD and commences recording pressure data. After a 160-second sampling period, the SAPMD returns to a power-down condition where it remains until turned back on by a command to the latch. This allows the system to be restarted in case of a misfire or delay.

The GSE will be used for interrogation, only, and will operate in the same manner as before, including supplying power to the SAPMD during interrogation.

While the SAPMD is in the power-down mode, the power drain will be less than 20 microamps of quiescent current of the regulator and latch circuitry.

2.3 Pressure Transducer

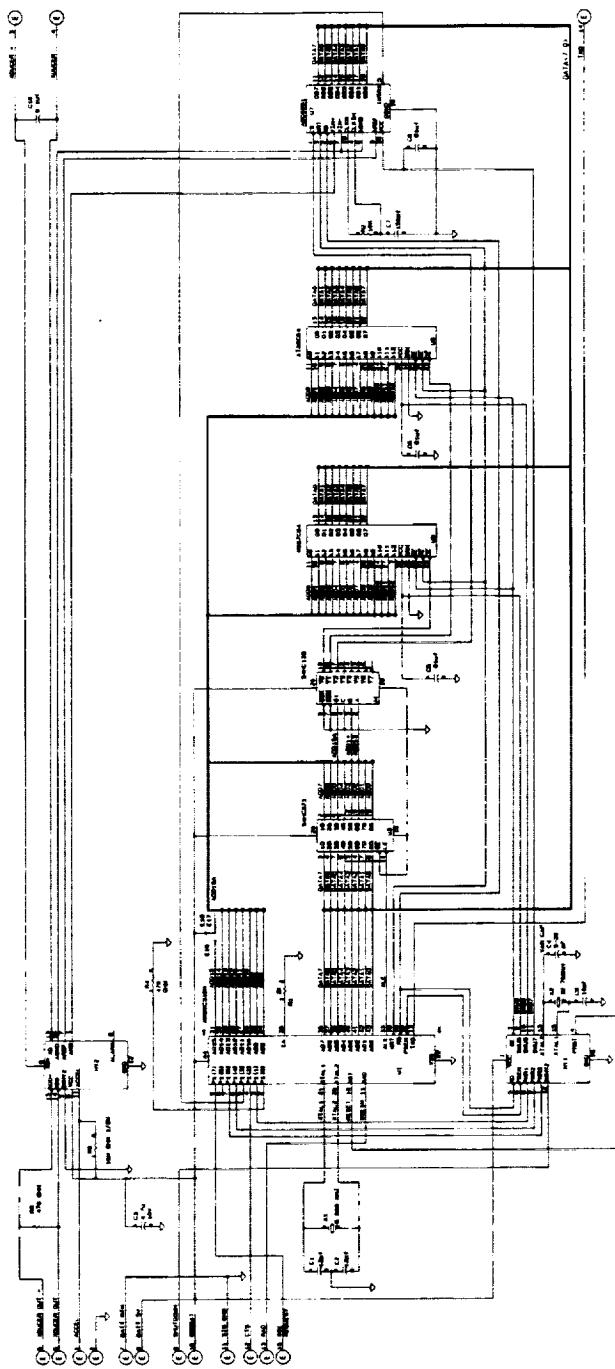
The pressure transducer selected is a standard Kulite XT-190 series ruggedized integrated sensor type absolute pressure transducer. The transducer is available with a maximum operating temperature of 350°F with a temperature compensated range of 100 to 300°F. The maximum change in sensitivity over the 100 to 300°F range is +/- 4.0 % with a repeatability of 0.05% of full scale with a 10 Vdc excitation voltage; the nominal output of the sensor is 100 mV full scale. The 8-bit resolution of the existing SAPMD A/D converter provides a theoretical resolution of 1000 psi/256 counts or 3.9 psi for the system. Actual measured performance of the present system indicates that a noise level of +/- 3 LSB can be expected which gives a +/- 11.7 psi noise level for the pressure measurements which combined with +/- 3 psi non-linearity and hysteresis and 0.5 psi repeatability gives an error factor of +/- 15.2 psi for single point measurements. The temperature coefficient of the transducer gives an expected error of +/- 40 psi. The frequency response of this transducer will allow it to track the sum of the average pressure and the instantaneous acoustic pressure.

2.4 Battery Design

The required longer operational lifetime of the SAPMD and some additional power requirements by the pressure sensor will require more available battery power. The present battery power supply consists of two 3.4V lithium cells connected in series to supply a nominal 6.8V to a linear regulator which reduces the voltage to 4.5V for the electronic circuits. To increase the battery lifetime, four cells will be used in a series-parallel arrangement to supply 6.8V at twice the amp-hr rating of the existing supply and will be regulated down to 5V for the supply of the electronic circuits by a micro-powered regulator on the new battery board.

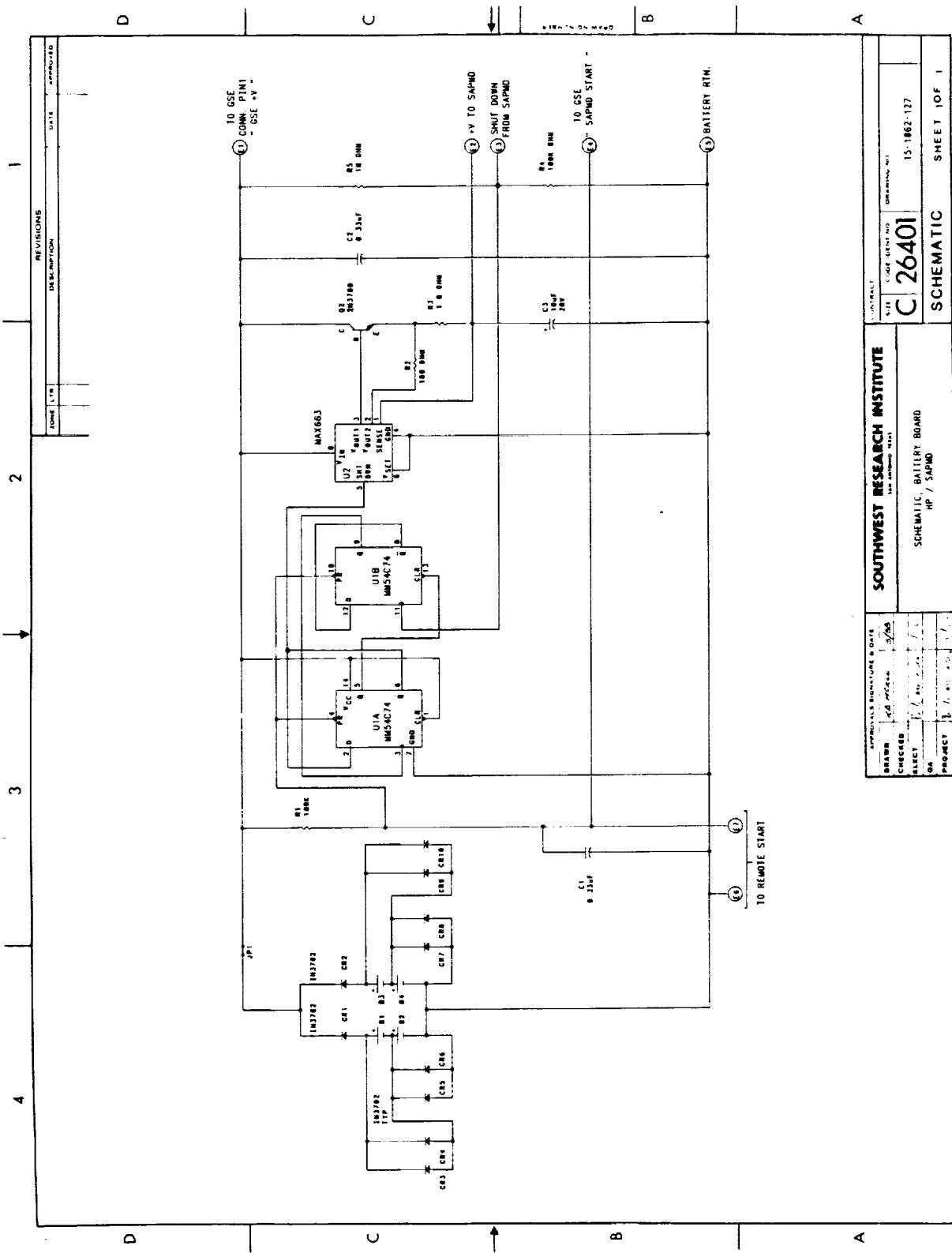
HP.SAPMD ELECTRONIC SCHEMATICS

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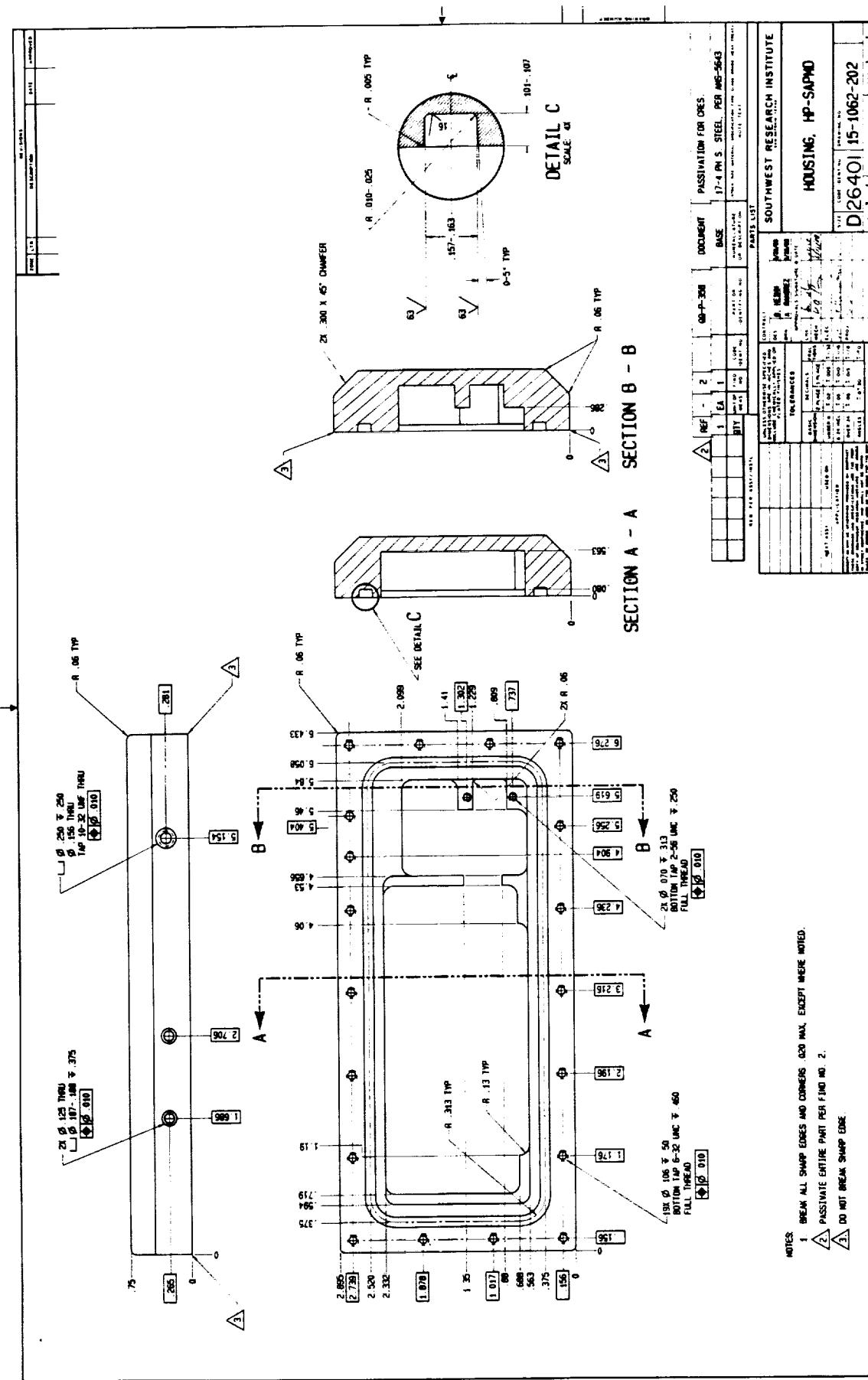


SOUTHWEST RESEARCH INSTITUTE	
DRAFT	
D26401	
PARTS LIST	
TOLERANCES	
EQUIPMENT	
TESTS	
MATERIALS	
MANUFACTURER'S DATA	
NOTES	

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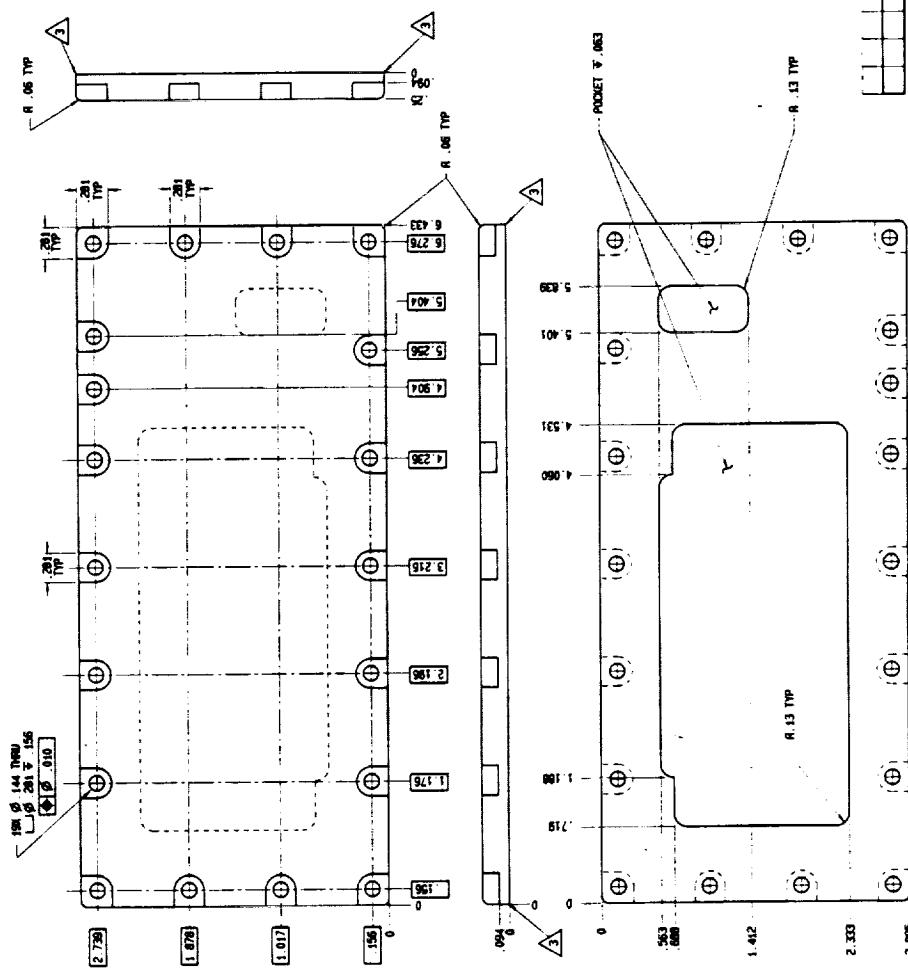


HP.SAPMD MECHANICAL SCHEMATICS



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NOTES: BREAK ALL SHARP EDGES AND CORNERS 600 MAX. EXCEPT WHERE NOTED.
2. PASSIVATE ENTIRE PART PER FIND NO. 2.
3. DO NOT BREAK ALL SHARP EDGE.

HP.SAPMD GSE SOFTWARE LISTINGS

The following files are include with this distribution:

HPSGA	EXE	72520	1-03-89	5:06p	Executable Program
README	HP	2765	1-03-89	5:53p	Program Notes
PACKING	LST	2198	1-03-89	6:23p	This file
HPSGA		1284	1-03-89	3:47p	MAKE file for HPSGA
HPSGALNK	LNK	121	1-03-89	3:48p	Link command file for HPSGA
CMDINT	C	30491	12-19-88	6:09p	C Source Files
DBCMND	C	9472	1-01-80	12:06a	
DEBUG	C	3468	1-03-89	3:50p	
DIPRESS	C	6561	1-03-89	4:00p	
ERROR	C	2745	12-28-88	12:32p	
HPSGA	C	264	12-28-88	1:59p	
MENU	C	3860	1-03-89	5:05p	
PRPRESS	C	2800	1-03-89	4:07p	
RECOVER	C	4122	12-29-88	4:29p	
SELFTEST	C	4332	1-03-89	5:03p	
STATUS	C	2359	1-03-89	3:51p	
SUPGLOB	C	9874	1-03-89	4:04p	
WINDOW	C	11136	1-01-80	4:05p	
CONIO	ASM	2304	1-01-80	10:36a	Assembly Source Files
FIO	ASM	8320	1-01-80	3:17p	
_WINDOW	ASM	7061	12-19-88	6:25p	
CONIO	LST	5501	12-19-88	6:26p	Assembly List Files
FIO	LST	17655	12-19-88	6:26p	
_WINDOW	LST	16591	12-19-88	6:25p	
CONIO	CRF	749	12-19-88	6:26p	Assembly Cross Reference Files
FIO	CRF	2937	12-19-88	6:26p	
_WINDOW	CRF	2378	12-19-88	6:25p	
HPSGA	MAP	17359	1-03-89	5:06p	Link map for HPSGA
CMDINT	OBJ	5872	1-03-89	4:09p	Object Modules
CONIO	OBJ	167	12-19-88	6:26p	
DBCMND	OBJ	2242	1-03-89	4:06p	
DEBUG	OBJ	1475	1-03-89	4:09p	
DIPRESS	OBJ	2297	1-03-89	4:07p	
ERROR	OBJ	1261	1-03-89	4:05p	
FIO	OBJ	790	12-19-88	6:26p	
HPSGA	OBJ	965	1-03-89	4:05p	
MENU	OBJ	2036	1-03-89	5:05p	
PRPRESS	OBJ	1636	1-03-89	4:07p	
RECOVER	OBJ	1203	1-03-89	4:07p	
SELFTEST	OBJ	1654	1-03-89	5:05p	
STATUS	OBJ	1194	1-03-89	4:07p	
WINDOW	OBJ	2261	1-03-89	4:05p	
_WINDOW	OBJ	639	12-19-88	6:25p	

```
# make file for hpsga
supglob.c : \include\stdio.h \include\process.h \include\stdlib.h
    m supglob.c      #allow change to supglob so that all else will compile

hpsga.obj : hpsga.c supglob.c
    cl /I\sapmd hpsga.c /c

window.obj : window.c supglob.c
    cl /I\sapmd window.c /c

error.obj : error.c supglob.c
    cl /I\sapmd error.c /c

dbcmd.obj : dbcmd.c supglob.c
    cl /I\sapmd dbcmd.c /c

menu.obj : menu.c supglob.c
    cl /I\sapmd menu.c /c

prpress.obj : prpress.c supglob.c
    cl /I\sapmd prpress.c /c

status.obj : status.c supglob.c
    cl /I\sapmd status.c /c

dipress.obj : dipress.c supglob.c
    cl /I\sapmd dipress.c /c

recover.obj : recover.c supglob.c
    cl /I\sapmd recover.c /c

selftest.obj : selftest.c supglob.c
    cl /I\sapmd selftest.c /c

cmdint.obj : cmdint.c supglob.c
    cl /I\sapmd cmdint.c /c

debug.obj : debug.c supglob.c
    cl /I\sapmd debug.c /c

_window.obj : _window.asm
    masm _window.asm,,,;

conio.obj : conio.asm
    masm conio.asm,,,;

fio.obj : fio.asm
    masm fio.asm,,,;

hpsga.exe : hpsga.obj window.obj _window.obj error.obj dbcmd.obj conio.obj \
fio.obj menu.obj prpress.obj status.obj dipress.obj recover.obj selftest.obj \
cmdint.obj debug.obj
    link @hpsgalnk.lnk
```

```

/********************* C M D I N T *****/
/*
/*          Command and interrogate the SAPMD.
/*
/********************* */
#include <supglob.c>
cmdint()
{
    int day,
        hh,
        mmss[2],
        cmd,
        i;
    unsigned char adrct[3];
    unsigned char *tptr;
    unsigned long ticks;
    screen.lines++;
    screen.curystyle++;
    menu(2,1);
    while (1)
    {
        wchs(CR);
        prompt(">");
        if ((i=rdln())==LEFT || i==HOME)
        {
            screen.lines--;
            screen.curystyle--;
            return(0);
        }
        switch (scan())
        {
/********************* */
/*
/*          SG, SM: Set GMT, MET
/*
/********************* */
        case SG:
            cmd=SETGMT;
            goto l1;
        case SM:
            cmd=SETMET;
l1:
        if (scan()==NUMBER && (day=acc)<=365) /* get day ...
            if (scan()==SLASH)           /* eat '/'
                if (scan()==NUMBER && (hh=acc)<24) /* get hour ...
                    {for (i=0;i<2;i++) /* get minutes and seconds
                        {if (scan()==COLON) /* get ':'
                            if (scan()==NUMBER && (mmss[i]=acc)<60)
                                continue; /* next iteration
                            break;}; /* exit loop on error
                        if (i>=2)           /* :hh:ss present?
                            if (scan()==EOL) /* good terminator?
                                {ticks=day*0x2a3001+(unsigned long)hh*7200+
                                    mmss[0]*120+mmss[1]*2; /* 1/2 secs*/
                                if (!sacmd(cmd,&ticks,4) || rdsg()!ACK)
                                    p_error(BADSAPMD); /* bad response
                                break;}; /* next command
                            error(BADCMD);
                            break; /* next
                        /*
/********************* */
/*
/*          TM: read GMT, MET
/*
/********************* */

```

```

        /*          */
        case TM:   /* read GMT      */
            if (scan()==EOL) /* check for good command */
                {adrct[0]=GMTADR; /* point to memory */
                 adrct[1]=8; /* send byte count */
                 if (!sacmd(DUMPRAM,adrct,2) || versg(RAMDATA)) /* issue */
                     {p_error(BADSAPMD); /* strange response */
                      break;}; /* next command */
                 rdtime();}; /* read and display times */
                 break; /* next */
                 /*          */
/****** */
/*          */
/*          DR: Dump 80C51 ram */
/*          */
/****** */
        /*          */
        case DR:   /* dump 80C51 ram */
            schex(); /* get address */
            adrct[0]=acc; /* save parameter */
            if (acc<=0x7f) /* check range */
                {adrct[1]=16; /* default byte count */
                 if (scan()==COMMA) /* check for count */
                     {if (scan()==NUMBER) /* a number there? */
                      {adrct[1]=acc & 0xff; /* make good number */
                       scan();}; /* get EOL */
                     else /* no number */
                         {error(BADCMD); /* strange command */
                          break;}; /* next */
                 if (token==EOL) /* check for garbage */
                     {if (!sacmd(DUMPRAM,adrct,2) || versg(RAMDATA))
                      p_error(BADSAPMD); /* print error */
                     else /* command ok */
                         dump(adrct[0],adrct[1]);/* read and print resp. */
                     break;}; /* next */
                 error(BADCMD); /* strange command */
                 break; /* next */
                 /*          */
/****** */
/*          */
/*          DS: Dump 80C51 SFR */
/*          */
/****** */
        /*          */
        case DS:   /* dump SFR      */
            if (schex()==NUMBER && (adrct[0]==acc)>0x7f && acc<=255) /* */
                if (scan()==EOL) /* good command? */
                    {if (!sacmd(DUMPSFR,adrct,1) || versg(SFRDATA))
                     p_error(BADSAPMD); /* send error */
                    else /* */
                        {adrct[1]=1; /* fake byte count */
                         dump(adrct[0],adrct[1]); /* display SFR contents*/
                         break;}; /* next */
                 error(BADCMD); /* strange command */
                 break; /* next */
                 /*          */
/****** */
/*          */
/*          DE: Dump external memory */
/*          */
/****** */
        /*          */
        case DE:   /* dump 80C51 ram */
            schex(); /* get address */
            adrct[0]=acc; /* save parameter */
            adrct[1]=acc>8; /* ... */

```

```

        adrct[2]=16;                      /* default byte count */
        if (scan()==COMMA)                /* check for count */
            {if (scan()==NUMBER)          /* a number there? */
                {adrct[2]=acc & 0xff;    /* make good number */
                 scan();} }
            else                           /* no number */
                {error(BADCMD);         /* strange command */
                 break;}};
        if (token==EOL)                  /* check for garbage */
            {if (!sacmd(DUMPEXT,adrct,3) || versg(EXTDATA))
                p_error(BADSAPMD);       /* print error */
            else
                dump(adrct[1]<<8|adrct[0],adrct[2]); /* read, print */
                break;}};
        error(BADCMD);                  /* strange command */
        break;                          /* next */
    /* **** */
    /* ER: Enter 80C51 ram */
    /* **** */
    case ER:                         /* enter ram */
        schex();                      /* get address */
        i=acc;                         /* save address */
        if (i<=127)                   /* check for good address */
            if (scan()==EOL)           /* check for good command */
                {enter(DUMPRAM,LOADRAM,i,0x7f,1,RAMDATA); /* ram */
                 break;}; }
        error(BADCMD);                /* strange command */
        break;                          /* next */
    /* **** */
    /* ES: Enter 80C51 SFR */
    /* **** */
    case ES:                         /* enter ram */
        schex();                      /* get address */
        i=acc;                         /* save address */
        if (i<=255 && i>=128)        /* check for good address */
            if (scan()==EOL)           /* check for good command */
                {enter(DUMPSFR,LOADSFR,i,0x7f,1,SFRDATA); /* load SFR*/
                 break;}; }
        error(BADCMD);                /* strange command */
        break;                          /* next */
    /* **** */
    /* EE: Enter EEPROM */
    /* **** */
    case EE:                          /* enter ram */
        schex();                      /* get address */
        i=acc;                         /* save address */
        if (scan()==EOL)               /* check for good command */
            {enter(DUMPEXT,LOADEE,i,0xffff,2,EXTDATA); /* load EEPROM*/
             break;}; }
        error(BADCMD);                /* strange command */
        break;                          /* next */
    /* **** */

```

```

/*
 * P: Program file into EEPROM
 */
/********************* */
/* case P:           /* program file
   if (i=prog()) error(i); /* read command
   break;           /* next
   */
/********************* */
/*
 * MON: Toggle ram display window
 */
/********************* */
/* case MON:        /* toggle monitor window
   if (m5->disp)  /* monitor window displayed?
     menu(2,0);    /* restore menu
   else             /* menu displayed
     menu(4,0);    /* display monitor window
   break;           /* next
   */
/********************* */
/*
 * CMD: Execute command file
 */
/********************* */
/* case CMD:        /* execute command file
   if (i=excfile()) error(i); /* open command file
   break;           /* next
   */
/********************* */
/*
 * LA: Set up for rubber launch
 */
/********************* */
/* case LA:          /* rubber launch
   if (scan()==NUMBER && (day=acc)<=365) /* get day ...
   if (scan()==SLASH)      /* eat '/'
   if (scan()==NUMBER && (hh=acc)<24) /* get hour ...
     {for (i=0;i<2;i++) /* get minutes and seconds
       {if (scan()==COLON) /* get ':'
         if (scan()==NUMBER && (mmss[i]=acc)<60)
           continue; /* next iteration
         break;};        /* exit loop on error
     if (i>=2)          /* :hh:ss present?
     if (scan()==EOL) /* good terminator?
       {ticks=day*0x2a3001+(unsigned long)hh*7200+
        mmss[0]*120+mmss[1]*2; /* 1/2 secs*/
       if ((cfile=fopen("la.cmd","rb"))==NULL)
         {error(NOLAFILE); /* no la.cmd*/
          break; /* bail out
        else /* good open
          cmdfile=1; /* flag cmd file
          tptr=(char *) &ticks; /* point to gmt
          adrct[0]=0; /* make address
          adrct[1]=0xb0; /* ...
          for (i=0;i<4;i++) /* plant gmt
            [adrct[2]=*tptr++; /* get tim*/
          if (!sacmd(LOADEE,adrct,3) || rdsg())
            {p_error(BADSAPMD);
             goto 12;}; /* bail out
             adrct[0]++;} /* next byte
           break;}; /* next command
           error(BADCMD); /* strange command
           */

```

```

/*
***** R P B Y T E *****
/*
/* Read and display byte. Check for errors.
/*
***** rpbyte() *****
rpbyte()
{unsigned char rch;
 int i;
 for (i=0;i<2;i++)
 {if ((rch=rdsg())==ABORT)
   {p_error(BADSAPMD);
    return(0);}
   wchs(rch);}
 return(1);}
/*
***** R D T I M E *****
/*
/* Read and display GMT and MET.
/*
***** rdtime() *****
rdtime()
{static char *gmetxt[]={ "GMT: ", "MET: "};
 int i,
 j,
 k,
 jtime[5];
union {unsigned char byt[4];
       unsigned long ticks;} time;
unsigned char timetxt[15];
for (i=0;i<2;i++)
{wchs(CR);
 stype(gmetxt[i]);
 for (j=0;j<4;j++)
 {for (k=0;k<2;k++)
   if ((timetxt[k]=rdsg())==ABORT)
     {p_error(BADSAPMD);
      return(0);}
   timetxt[2]='\0';
   time.byt[j]=bhextimetxt(j);}
 dcdtime(jtime,time);
 printf("%3d/%2d:%2d.%2d.%ld",jtime[0],jtime[1],jtime[2],jtime[3],
       jtime[4]);}}
/*
***** D C D T I M E *****
/*
/* Convert binary time to ascii string.
/*
***** dcdtime(btime,atime) *****
dcdtime(btime,atime)
int btime[];
unsigned long atime;
{static unsigned long cnv[]={0x2a3001,72001,1201,21}; /* conversion const*/
 int i;
 for (i=0;i<4;i++)
 {btime[i]=atime/cnv[i];
  atime-=btime[i]*cnv[i];}}
/*

```

```

12:                                /* error exit
        break;                      /* next
                                    */
/******
*/
/*      EOL
*/
*****                                     */
    case EOL:                            /* EOL
        break;                           /* ignore blank line
                                    */
/******
*/
/*      QUIT
*/
*****                                     */
    case Q:                             /* quit
        scrup(0,0,24,79,0);           /* clear screen
        i=inp(0x21);                /* read 8259 interrupt mask
        outp(0x21,i|0x10);          /* stop serial interrupts
        exit(0);                    /* stop.
    default:                           /* otherwise
        error(BADCMD);}}}}         /* unrecognized command
                                    */

/******
*/
/*          H E X W
*/
/*      Print the passed word in hex.
*/
*****                                     */
hexw(id,x)                            /* display hex word
    struct window *id;                 /* window id
    int x;                            /* data
    {hex(id,x>>8);               /* display high ...
    hex(id,x);}                     /* ... and low
                                    */

/******
*/
/*          H E X C
*/
/*      Convert the passed nibble to hex ascii.
*/
*****                                     */
char hexc(x)                           /* convert to hex ascii
    int x;                            /* nibble
    {x&=0xf;                         /* get nibble
    return((x<=9)?x+'0':x-10+'A');} /* convert to ascii
                                    */

/******
*/
/*          H E X
*/
/*      Print the specified byte at the current cursor position on the
/*      specified window.
*/
*****                                     */
hex(id,x)                            /* print byte in hex
    struct window *id;               /* window id
    int x;                            /* data
    {wchw(id,hexc(x>>4));}       /* print high nibble

```

```

purge();
if (sgch(cmd)) return(0);
for (i=0;i<plen;i++)
{chex(*part++,hxcmd);
 for (j=0;j<2;j++)
 if (sgch(hxcmd[j]))
 return(0);};
if (sgch(CR)) return(0);
return(1);}

/********************* S G C H ********************
/*
/*      Send character to SAPMD and get response byte.
/*
sgch(cmd)
int cmd;
{int rch;
wrsg(cmd);
return(versg(cmd));}

/********************* V E R S G ********************
/*
/*      Verify response from SAPMD
/*
versg(cmd)
int cmd;
{int rch;
rch=rdsg();
if (rch==cmd) return(0);
while (rch!=ABORT)
{wrsg(ILNK);
rch=rdsg();};
return(1);}

/********************* D U M P ********************
/*
/*      Read and display dumped data.
/*
dump(addr,len)
int addr,
len;
{int i,
j,
k;
for (i=len;i>0;i-=16)
{wchs(CR);
hexw(&screen,addr);
wchs(':' );
wchs(' ');
addr+=16;
k=0;
for (j=i>16?16:i;j>0;j--)
{wchs(k++==8?'-': ' ');
if (!rpbyte()) return(0);}}};

/* empty garbage in buffer
/* issue command byte
/* issue parameter bytes
/* convert parameter byte
/* send bytes
/* issue byte and get resp.
/* good response?
/* good termination?
/* return good completion
*/
/*
/*      send character to SAPMD
/* command character
/* response byte
/* send byte
/* return response
*/
/*
/* verify response from SAPMD
/* command character
/* response byte
/* get response byte
/* good response?
/* abort command
/* send abort command
/* get response
/* return response
*/
/*
/*      dump memory
/* address
/* byte count
/* iteration variable
/* iteration variable
/* byte counter
/* count bytes displayed
/* new line
/* display address
/* separate address
/*
/* next address
/* printed byte counter
/* count bytes on line
/*
/* read and print byte
*/
/*

```

```

wchw(id,hexc(x));}                                /* print low nibble
/*                                                 */
*****                                                 */
/*
/*
/*
/*          C H E X
/*
/*
/*      Convert byte to ascii hex string.
/*
/*
*****                                                 */
chex(byt,str)                                     /*
    unsigned char byt;                            /* convert to ascii hex
    char *str;                                    /* binary data
{ *str=hexc(byt>>4);                          /* string
    str++;                                       /* convert high nibble
    *str=hexc(byt);}                           /* next byte in string
                                                /* ... and low
                                                */
/*
*****                                                 */
/*
/*
/*
/*          B H E X
/*
/*
/*      Convert ascii hex string to int.
/*
/*
*****                                                 */
bhex(hstr)                                         /*
    char *hstr;                                    /* hex ascii string to int
    {int a;                                         /* character string
        a=0;                                         /* accumulator
        while (*hstr!='\0')                         /* clear accumulator
            {a=a*16+(*hstr<='9'?*hstr-'0':*hstr-'A'+10); /* convert until end
                hstr++;}                            /* accumulate
                                                /* next character
    return(a);}                                     /* return value
                                                */
/*
*****                                                 */
/*
/*
/*
/*          E N T E R
/*
/*
/*      Enter data into SC-1 memory.
/*
/*
*****                                                 */
enter(cmd,cme,adr,maxadr,alen,dtype)             /*
    int cmd,                                         /* change target memory
        cme,                                         /* dump command
        adr,                                         /* enter command
        maxadr,                                       /* start address
        alen,                                         /* highest address
        dtype;                                         /* address length
    {int i,                                         /* response type
        c,                                            /* iteration variable
        cflag;                                       /* character counter
        union {char bpar[3];
                int wpar;} caddr;                      /* change flag
    while (1)                                       /* parameter list
        {wchs(CR);
            hexw(&screen,adr);
            wchs(':');
            wchs(' ');
            for (i=0;i<8;i++)
                {caddr.wpar=adr++;
                    caddr.bpar[alen]=1;
                    if (!sacmd(cmd,&caddr,cmd!=DUMPSFR?alen+1:1)||versg(dtype))
                        {p_error(BADSAPMD);
                            return(0);}
                    if (!rpbyte()) return(0);
                    /* ---> return
                    /* get contents
*/
```



```

wchs(' ');
hex(&screen,addr.a[2]); /* print data */
if (!sacmd(LOADEE,addr.a,3) || rdsg() !=ACK) /* issue cmd*/
    {fclose(hxf); /* close file */
     p_error(BADSAPMD); /* signal error */
     return(0);}; /* return no error */
    ip+=2; /* next byte */
    addr.b++;}; /* next address */
break; /* next record */
case 1: /* eof */
return(0); /* file ok */
default: /* else */
return(BADFILE);}} /* strange file */
/*
***** */

/*
/* E X C F I L E
*/
/*
/* Open command file.
*/
/*
***** */

excfile()
{
int i;
skbl(); /* skip blanks to filename */
if (*iptr==CR) return(NOFILE);
for (i=0;i<sizeof(line);i++)
    if (line[i]==CR) line[i]=0;
if ((cfile=fopen(iptr,"rb"))==NULL)
    return(NOFILE);
else
    {cmdfile=1;
    return(0);}}
/*
***** */

/*
/* B H X
*/
/*
/* Convert ascii hex byte to int.
*/
/*
***** */

bhx(hstr)
char *hstr; /* hex ascii string to int */
int a,i; /* character string */
a=0; /* accumulator */
for (i=0;i<2;i++) /* clear accumulator */
    /* convert until end */
    {a=a*16+(*hstr<='9'?*hstr-'0':*hstr-'A'+10); /* accumulate */
     hstr++;}; /* next character */
return(a);}
/*
***** */

/*
/* P E R R O R
*/
/*
/* Print error and purge SAPMD response buffer.
*/
/*
***** */

p_error(msg)
int msg;
{error(msg);
purge();}
/*
/* error and purge */
/* message number */
/* signal error */
/* empty response buffer */
/*
***** */

```

```
*****
/* S C A N
 */
/* SCAN acquires user commands and turns them into lexical units for
/* processing by callers. The integer returned is the token id, which is
/* also placed in the global variable 'token'.
*/
*****  

#include <supglob.c>  

scan()  

{acc=0;  

 skbl();  

 if (*iptr>='0' && *iptr<='9')  

 {while (*iptr>='0' && *iptr<='9')  

 acc=acc*10+*iptr++-'0';  

 return(token=NUMBER);}  

else  

 return(fid());}  

*****  

/* S K B L
 */
/* Skip blanks.  

*****  

skbl()  

{while (*iptr==' ') iptr++;}  

*****  

/* F I D
 */
/* Match the longest string in the input line.  

*****  

fid()  

{int i;  

 struct name {char *ntxt;  

 int tkn;};  

 char *nm,  

 *npt;  

 static struct name idnt[]={"DE",DE,  

 "DR",DR,  

 "DS",DS,  

 "EE",EE,  

 "ER",ER,  

 "ES",ES,  

 "LA",LA,  

 "MON",MON,  

 "P",P,  

 "SG",SG,  

 "SM",SM,  

 "TM",TM,  

 "Q",Q,  

 ",",COMMA,  

 ":" ,COLON,  

 "/",SLASH,  

 "@",CMD,  

 "=" ,EQU};  

 for (i=0;i<sizeof(idnt)/sizeof(struct name);i++) /* search for match
/* locate global data
/* SCAN
/* clear number accumulator
/* skip blanks
/* check for number
/* accumulate #
/* add digit
/* return a number
/* check for identifier/mark
/* search for id/mark
/* eat blanks
/* skip blanks
/* find identifier
/* iteration variable
/* identifier
/* token
/* pointer to command text
/* input pointer
/* dump code
/* dump ram
/* dump SFR
/* enter EEPROM
/* enter ram
/* enter SFR
/* rubber launch
/* monitor
/* program
/* set GMT
/* set MET
/* time
/* quit
/* comma
/* colon
/* slash
/* at-sign
/* equal
```

```

{nm=idnt[i].ntxt; /* point at command */
  for (npt=iptr,*nm==*iptr;iptr++) nm++; /* compare strings */
  if (*nm=='\0') /* a match? */
    return(token=idnt[i].tkn); /* ... yep, return token */
  iptr=npt; /* back up input */
  if (*iptr==CR) return(token=EOL); /* carriage return? */
  return(token=BADCHAR);} /* strange identifier */
}

/*
 *          S C H E X
 *
 *      SCHEX attempts to read hex numbers.
 */
schex()
{
acc=0; /* scan hex number */
while (*iptr==' ') iptr++; /* clear accumulator */
token=NUL; /* skip blanks */
while (1) /* guess missing number */
  {
  switch (*iptr)
    {
    case '0': /* loop till end-of-number */
    case '1': /* what is the first char? */
    case '2': /* check for numbers */
    case '3': /* */
    case '4': /* */
    case '5': /* */
    case '6': /* */
    case '7': /* */
    case '8': /* */
    case '9': /* */
      acc=acc*16+*iptr++-'0'; /* */
      token=NUMBER; /* a number */
      break; /* next */
    case 'A': /* */
    case 'B': /* */
    case 'C': /* */
    case 'D': /* */
    case 'E': /* */
    case 'F': /* */
      acc=acc*16+*iptr++-'A'+10; /* */
      token=NUMBER; /* a number */
      break; /* next */
    default: /* end-of-number */
      return(token); } } /* return */
}

/*
 *          P R O M P T
 *
 *      Prompt for user keyboard input.
 */
prompt(prmp)
{
char *prmp; /* ask user */
{scrup(24,0,24,79,0); /* prompt string */
  movcurs(24,0); /* erase line */
  for (;*prmp]!='\0';prmp++) wch(*prmp); /* position cursor */
  /* write prompt string */
}

/*
 *          R D L N
 *
 *      Read keyboard input until an activation character is encountered.
 */

```

```

/*
 ****
 */

rdln()
{
    int j;
    static char splch[]={'H','P','M','K',
                         'Q','I','R','S',
                         'G','O',';','<'};
    static char spltkn[]={UP,DOWN,RIGHT,LEFT,
                         PGDN,PGUP,INS,DEL,
                         HOME,ND,CTA,CTR};
    iptr=line;
    while (1)
        if ((ch=rdch())!=(char)0xff)
            switch (ch)
                {
                    case CTRLC:
                        j=inp(0x21);
                        outp(0x21,j|0x10);
                        popcurs();
                        exit(0);
                    case CR:
                        *iptr=CR;
                        iptr=line;
                        return(EOL);
                    case SPL:
                        ch=rdch();
                        for (j=0;j<sizeof(splch);j++) /* look for special char.
                            if (splch[j]==ch) /* is this it?
                                [if (spltkn[j]==DEL) /* del?
                                    {ch=BACKSPACE; /* fake backspace
                                    goto 11;};
                                else
                                    *iptr=CR; /* plant character code
                                    iptr=line; /* point at start of input
                                    return(spltkn[j]);}; /* return it
                            break;
                        11:
                    case BACKSPACE:
                        if (line!=iptr)
                            {wrch(ch);
                            wrch(' ');
                            wrch(ch);
                            --iptr;};
                    case LF:
                        break;
                    default:
                        if (echo)
                            [*iptr++=toupper(ch);
                            wrch(ch);}];
                }
}

/*
 ****
 R D C H
 ****
 */
/* Read keyboard input until a character is encountered. Poll for
/* SAPMD status.
*/
****

rdch()
{
    unsigned char ch;
    if (!polst())
        {pshcurs();
        status();
        popcurs();};
    if (cmdfile)
        {ch=fgetc(cfile);
        /* read character
        /* returned character
        /* any status data?
        /* ... yep, save cursor pos.
        /* display status
        /* restore cursor position
        /* command file open?
        /* get high nibble ...
}

```

```

if (!(ch==EOF) && (!feof(cfile))) return(ch); /* EOF?
fclose(cfile);
cmdfile=0;};
return(rdc());}

/*********************************************
/*
/* R D S G
/*
/* Read SAPMD input until a character is detected. Poll for
/* SAPMD status.
/*
/*********************************************
/*
/* read SAPMD
/* any response from SAPMD?
/* check for status data
/* ... yep, save cursor pos.
/* display status
/* restore cursor position
/* read SAPMD character
/*
/*********************************************

```



```

    outp(0x21,i|0x10);           /* stop serial interrupts */
    exit(0);                    /* stop. */
if (token==CMD)              /* command file? */
{ if (i=excfile()) error(i); } /* open command file */
else                          /* not a command file? */
    if (token!=EOL) error(BADCMD);}/* null line? */
    /* */
/* **** */

```

```

/********************* D I P R E S S ********************/
/*
/*                                D I P R E S S
/*
/*      Display pressure data file.
/*
/********************* dipress() ****************************
/*          /* locate global data
/*          /* display data
/*          /* iteration variable
/*          /* page number
/*          /* get file name
/*          /* add line for bottom
/*          /* save cursor attributes
/*          /* display window
/*          /* display 1st page
/*          /* current data index
/*          /* clear echo flag
/*          /* loop forever
/*          /* read keypad
/*          /* page up
/*
/*          /* not 1st page?
/*          /* back up page
/*          /* display data
/*          /* next
/*          /* page down
/*
/*          /* more data?
/*          /* page down
/*          /* display data
/*          /* next
/*          /* bail out
/*
/*          /* restore screen size
/*          /* echo characters again
/*          /* restore cursor
/*          /* ---> return
/*
/*          /* else
/*          /* ignore
/*
/********************* P R P A G E ****************************
/*
/*                                P R P A G E
/*
/*      Display a page of pressure data.
/*
/********************* prpage(sm) ****************************
/*          /* display page
/*          /* starting sample
/*          /* window header
/*          /* SAMPLE           PRESSURE */
/*          /* iteration variable
/*          /* iteration variable
/*          /* iteration variable
/*          /* erase window
/*          /* first line
/*          /* space
/*          /* print heading
/*          /* 2 columns
/*          /* move to top of window
/*          /* ... for serial #
/*          /* ...
*/

```

```

printf("SAPMD SERIAL #%-5d",sm->serial); /* print serial #
for (j=0;j<20;j++)
    if (sm<samptr) /* good sample?
        {m6->curx=i; /* position cursor
         m6->cury++;
         cursor(m6);
         printf("%3d %5.2f",sm->sample, sm->press);
         sm++;}
movcurs(24,1); /* next sample
setcurs(0x3000); /* hide cursor
/* one line long
*/
***** G E T F I L E
/*
/* Get pressure data file and process.
/*
getfile()
{
FILE *pfile;
unsigned char pdata[8192],
            *pdptr;
union {unsigned char byt[4];
       unsigned long tm;} tick;
char ah[3];
union {int i;
       unsigned char b[2];} s,
                           serial;
int i,
    j,
    k,
    p,
    m,
    adjust,
    pnum;
float coef;
coef=.058594;
adjust=0;
prompt("ENTER FILENAME: ");
if ((i=rldn())==HOME || i==LEFT) return(0); /* read filename
skbl(); /* skip blanks to filename
if (*iptr==CR) return(0); /* null line?
for (i=0;i<sizeof(line);i++)
    if (line[i]==CR) line[i]=0;
if ((pfile=fopen(iptr,"rb"))==NULL)
    return(0);
else
    {for (p=0;;p++)
        {ah[0]=fgetc(pfile);
         ah[1]=fgetc(pfile);
         ah[2]='\0';
         if (feof(pfile)) break;
         pdata[p]=bhex(ah);}
    fclose(pfile);
    pdptr=pdata;
    samptr=prsam;
    serial.b[1]=*pdptr++;
    serial.b[0]=*pdptr++;
    for (j=0;j<sizeof(sapmd)/sizeof(struct cal);j++)/* cal. coef.
        if (sapmd[j].serial==serial.i) /* is this one calibrated?
            {coef=sapmd[j].coef; /* set cal. coef.
             adjust=sapmd[j].offset; /* set calibration offset
             break;};
    for (j=0;j<4;j++) tick.byts[j]=*pdptr++; /* get GMT
    tick.tm*=51; /* convert to 100 msec units
}
}
/*
/* display data
/* pressure data file
/* pressure data
/* pressure data pointer
/* time bytes
/* hex ascii character buffer
/* sample index
/* SAPMD serial number
/* iteration variable
/* iteration variable
/* iteration variable
/* eod index in pdata
/* # samples in file
/* Bennie's constant
/* page number
/* calibration coef.
/* default FF=15.0 psi
/* default offset
/* prompt for file
/* read filename
/* skip blanks to filename
/* null line?
/* stomp EOL
/* ...
/* file exist?
/* return error
/* file opened
/* eof?
/* get high nibble ...
/* ... and low
/* terminate string
/* EOF?
/* convert to binary
/* close file
/* point to pressure data
/* point to processed data
/* get serial number
/* ...
/* cal. coef.
/* is this one calibrated?
/* set cal. coef.
/* set calibration offset
/* ...
/* get GMT
/* convert to 100 msec units
*/

```

```
m = ( p - 6 ) / 2;          /* find amount of data      */
for (k=0;k<m;k++)           /* scan pressure data file */
{ s.i=k;                   /* establish index          */
  s.b[0]=*pdptr++;         /* get sample number        */
  samptr->sample=s.i;      /* number sample            */
  j=*pdptr++;              /* convert from char. to int */
  samptr->press=(j<adjust?0:j-adjust)*coef; /* */
  samptr->serial=serial.i; /* mark source SAPMD        */
  samptr++;}};               /* next sample               */
/* good file                 */
/* ****                         */
return(1);
```